

Buffered 8-Channel, 16-Bit, 800ksps Differential $\pm 10.24\text{V}$ ADC with 30V_{P-P} Common Mode Range

FEATURES

- Eight Buffered Multiplexed Channels
- 800ksps Throughput
- 500pA/12nA Maximum Input Leakage at 85°C/125°C
- $\pm 1\text{LSB}$ INL (Maximum $\pm 10.24\text{V}$ Range)
- Guaranteed 16-Bit, No Missing Codes
- Differential, Wide Common Mode Range Inputs
- 8-Channel Multiplexer with SoftSpan Input Ranges:
 $\pm 10.24\text{V}$, 0V to 10.24V, $\pm 5.12\text{V}$, 0V to 5.12V
 $\pm 12.5\text{V}$, 0V to 12.5V, $\pm 6.25\text{V}$, 0V to 6.25V
- 94.2dB Single-Conversion SNR (Typical)
- -110dB THD (Typical) at $f_{\text{IN}} = 2\text{kHz}$
- 128dB CMRR, -125dB Active Crosstalk (Typical)
- 420ns Step Response (Full-Scale, 0.005% Settling)
- Rail-to-Rail Input Overdrive Tolerance
- Programmable Sequencer with No-Latency Control
- Integrated Reference and Buffer (4.096V)
- SPI CMOS (1.8V to 5V) and LVDS Serial I/O
- 268mW Power Dissipation (Typical)
- 48-Lead (7mm \times 7mm) LQFP Package

APPLICATIONS

- Direct Sensor Measurement
- Programmable Logic Controllers
- Industrial Process Control
- Test and Measurement

DESCRIPTION

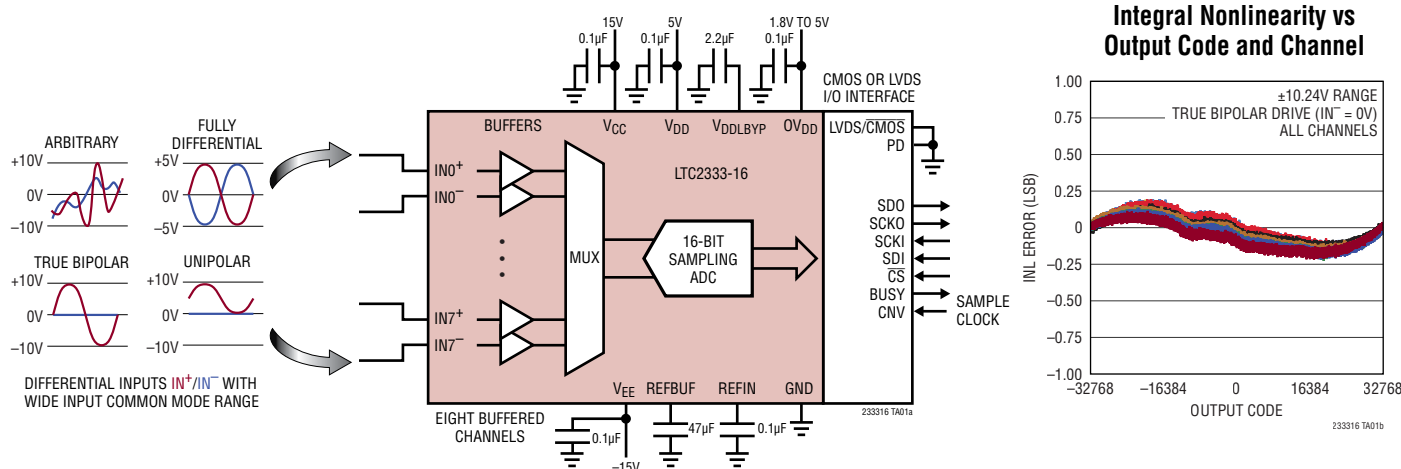
The LTC[®]2333-16 is a 16-bit, low noise 8-channel multiplexed successive approximation register (SAR) ADC with buffered differential, wide common mode range picoamp inputs. Operating from a 5V low voltage supply, flexible high voltage supplies, and using the internal reference and buffer, this SoftSpan[™] ADC can be configured on a conversion-by-conversion basis to accept $\pm 10.24\text{V}$, 0V to 10.24V, $\pm 5.12\text{V}$, or 0V to 5.12V signals on any channel. Alternately, the ADC may be programmed to cycle through a sequence of channels and ranges without further user intervention.

The integrated picoamp-input analog buffers, wide input common mode range and 128dB CMRR of the LTC2333-16 allow the ADC to directly digitize a variety of signals using minimal board space and power. This input signal flexibility, combined with $\pm 1\text{LSB}$ INL, no missing codes at 16 bits, and 94.2dB SNR, makes the LTC2333-16 an ideal choice for many high voltage applications requiring wide dynamic range.

The LTC2333-16 supports pin-selectable SPI CMOS (1.8V to 5V) and LVDS serial interfaces.

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TYPICAL APPLICATION



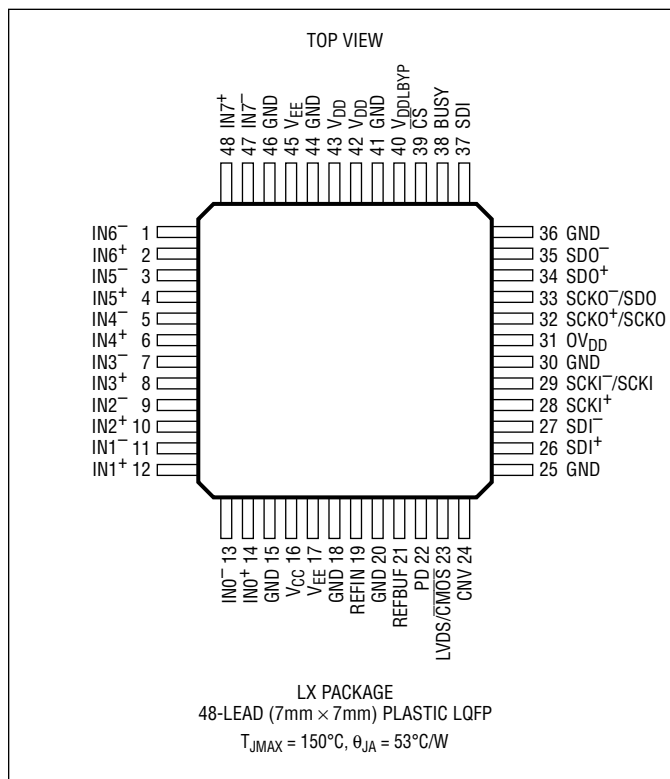
LTC2333-16

ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2)

Supply Voltage (V_{CC})	-0.3V to ($V_{EE} + 40V$)
Supply Voltage (V_{EE})	-17.4V to 0.3V
Supply Voltage Difference ($V_{CC} - V_{EE}$)	40V
Supply Voltage (V_{DD})	6V
Supply Voltage (OV_{DD})	6V
Internal Regulated Supply Bypass (V_{DDLBY})	...	(Note 3)
Analog Input Voltage		
$IN0^+$ to $IN7^+$,		
$IN0^-$ to $IN7^-$ (Note 4)	($V_{EE} - 0.3V$) to ($V_{CC} + 0.3V$)
REFIN	-0.3V to 2.8V
REFBUF, CNV (Note 5)	-0.3V to ($V_{DD} + 0.3V$)
Digital Input Voltage (Note 5)	-0.3V to ($OV_{DD} + 0.3V$)
Digital Output Voltage (Note 5)	..	-0.3V to ($OV_{DD} + 0.3V$)
Power Dissipation	500mW
Operating Temperature Range		
LTC2333C	0°C to 70°C
LTC2333I	-40°C to 85°C
LTC2333H	-40°C to 125°C
Storage Temperature Range	-65°C to 150°C

PIN CONFIGURATION



ORDER INFORMATION <http://www.linear.com/product/LTC2333-16#orderinfo>

TRAY	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC2333CLX-16#PBF	LTC2333LX-16	48-Lead (7mm × 7mm) Plastic LQFP	0°C to 70°C
LTC2333ILX-16#PBF	LTC2333LX-16	48-Lead (7mm × 7mm) Plastic LQFP	-40°C to 85°C
LTC2333HLX-16#PBF	LTC2333LX-16	48-Lead (7mm × 7mm) Plastic LQFP	-40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandreel/>. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 6)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{IN+}	Absolute Input Range (IN0+ to IN7+)	(Note 7)	●	$V_{EE} + 4$	$V_{CC} - 4$	V
V_{IN-}	Absolute Input Range (IN0- to IN7-)	(Note 7)	●	$V_{EE} + 4$	$V_{CC} - 4$	V
$V_{IN+} - V_{IN-}$	Input Differential Voltage Range	SoftSpan 7: $\pm 2.5 \cdot V_{REFBUF}$ Range (Note 7) SoftSpan 6: $\pm 2.5 \cdot V_{REFBUF}/1.024$ Range (Note 7) SoftSpan 5: 0V to $2.5 \cdot V_{REFBUF}$ Range (Note 7) SoftSpan 4: 0V to $2.5 \cdot V_{REFBUF}/1.024$ Range (Note 7) SoftSpan 3: $\pm 1.25 \cdot V_{REFBUF}$ Range (Note 7) SoftSpan 2: $\pm 1.25 \cdot V_{REFBUF}/1.024$ Range (Note 7) SoftSpan 1: 0V to $1.25 \cdot V_{REFBUF}$ Range (Note 7) SoftSpan 0: 0V to $1.25 \cdot V_{REFBUF}/1.024$ Range (Note 7)	● ● ● ● ● ● ● ●	$-2.5 \cdot V_{REFBUF}$ $-2.5 \cdot V_{REFBUF}/1.024$ 0 0 $-1.25 \cdot V_{REFBUF}$ $-1.25 \cdot V_{REFBUF}/1.024$ 0 0	$2.5 \cdot V_{REFBUF}$ $2.5 \cdot V_{REFBUF}/1.024$ $2.5 \cdot V_{REFBUF}$ $2.5 \cdot V_{REFBUF}/1.024$ $1.25 \cdot V_{REFBUF}$ $1.25 \cdot V_{REFBUF}/1.024$ $1.25 \cdot V_{REFBUF}$ $1.25 \cdot V_{REFBUF}/1.024$	V V V V V V V V
V_{CM}	Input Common Mode Voltage Range	(Note 7)	●	$V_{EE} + 4$	$V_{CC} - 4$	V
$V_{IN+} - V_{IN-}$	Input Differential Overdrive Tolerance	(Note 8)	●	$-(V_{CC} - V_{EE})$	$(V_{CC} - V_{EE})$	V
$I_{OVERDRIVE}$	Input Overdrive Current Tolerance	$V_{IN+} > V_{CC}$, $V_{IN-} > V_{CC}$ (Note 8) $V_{IN+} < V_{EE}$, $V_{IN-} < V_{EE}$ (Note 8)	● ●	0	10	mA mA
I_{IN}	Analog Input Leakage Current	C-Grade and I-Grade H-Grade	● ●	5	500 12	pA pA nA
R_{IN}	Analog Input Resistance	For Each Pin		>1000		GΩ
C_{IN}	Analog Input Capacitance			3		pF
CMRR	Input Common Mode Rejection Ratio	$V_{IN+} = V_{IN-} = 18V_{P-P}$ 200Hz Sine	●	105	128	dB
V_{IHCNV}	CNV High Level Input Voltage		●	1.3		V
V_{ILCNV}	CNV Low Level Input Voltage		●		0.5	V
I_{INCNV}	CNV Input Current	$V_{IN} = 0V$ to V_{DD}	●	-10	10	μA

CONVERTER CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 9)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
	Resolution		●	16			Bits
	No Missing Codes		●	16			Bits
	Transition Noise	SoftSpans 7 and 6: ±10.24V and ±10V Ranges SoftSpans 5 and 4: 0V to 10.24V and 0V to 10V Ranges SoftSpans 3 and 2: ±5.12V and ±5V Ranges SoftSpans 1 and 0: 0V to 5.12V and 0V to 5V Ranges		0.35 0.7 0.5 1.1			LSB _{RMS} LSB _{RMS} LSB _{RMS} LSB _{RMS}
INL	Integral Linearity Error	SoftSpans 7 and 6: ±10.24V and ±10V Ranges (Note 10) SoftSpans 5 and 4: 0V to 10.24V and 0V to 10V Ranges (Note 10) SoftSpans 3 and 2: ±5.12V and ±5V Ranges (Note 10) SoftSpans 1 and 0: 0V to 5.12V and 0V to 5V Ranges (Note 10)	● ● ● ●	-1 -1.25 -1 -1.5	±0.3 ±0.4 ±0.3 ±0.5	1 1.25 1 1.5	LSB LSB LSB LSB
DNL	Differential Linearity Error	(Note 11)	●	-0.9	±0.2	0.9	LSB
ZSE	Zero-Scale Error	(Note 12)	●	-700	±160	700	µV
	Zero-Scale Error Drift			±4			µV/°C
FSE	Full-Scale Error	V _{REFBUF} = 4.096V (REFBUF Overdriven) (Note 12)	●	-0.1	±0.025	0.1	%FS
	Full-Scale Error Drift	V _{REFBUF} = 4.096V (REFBUF Overdriven) (Note 12)		±2.5			ppm/°C

DYNAMIC ACCURACY The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $A_{IN} = -1\text{dBFS}$. (Notes 9, 13)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SINAD	Signal-to-(Noise + Distortion) Ratio	SoftSpans 7 and 6: $\pm 10.24\text{V}$ and $\pm 10\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	● 91.6	94.1		dB
		SoftSpans 5 and 4: 0V to 10.24V and 0V to 10V Ranges, $f_{IN} = 2\text{kHz}$	● 86.7	89.6		dB
		SoftSpans 3 and 2: $\pm 5.12\text{V}$ and $\pm 5\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	● 88.8	91.5		dB
		SoftSpans 1 and 0: 0V to 5.12V and 0V to 5V Ranges, $f_{IN} = 2\text{kHz}$	● 83.4	86.3		dB
SNR	Signal-to-Noise Ratio	SoftSpans 7 and 6: $\pm 10.24\text{V}$ and $\pm 10\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	● 92.0	94.2		dB
		SoftSpans 5 and 4: 0V to 10.24V and 0V to 10V Ranges, $f_{IN} = 2\text{kHz}$	● 86.9	89.7		dB
		SoftSpans 3 and 2: $\pm 5.12\text{V}$ and $\pm 5\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	● 88.9	91.5		dB
		SoftSpans 1 and 0: 0V to 5.12V and 0V to 5V Ranges, $f_{IN} = 2\text{kHz}$	● 83.5	86.3		dB
THD	Total Harmonic Distortion	SoftSpans 7 and 6: $\pm 10.24\text{V}$ and $\pm 10\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	●	-110	-101	dB
		SoftSpans 5 and 4: 0V to 10.24V and 0V to 10V Ranges, $f_{IN} = 2\text{kHz}$	●	-110	-99	dB
		SoftSpans 3 and 2: $\pm 5.12\text{V}$ and $\pm 5\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	●	-114	-102	dB
		SoftSpans 1 and 0: 0V to 5.12V and 0V to 5V Ranges, $f_{IN} = 2\text{kHz}$	●	-115	-101	dB
SFDR	Spurious Free Dynamic Range	SoftSpans 7 and 6: $\pm 10.24\text{V}$ and $\pm 10\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	● 101	111		dB
		SoftSpans 5 and 4: 0V to 10.24V and 0V to 10V Ranges, $f_{IN} = 2\text{kHz}$	● 100	111		dB
		SoftSpans 3 and 2: $\pm 5.12\text{V}$ and $\pm 5\text{V}$ Ranges, $f_{IN} = 2\text{kHz}$	● 102	115		dB
		SoftSpans 1 and 0: 0V to 5.12V and 0V to 5V Ranges, $f_{IN} = 2\text{kHz}$	● 104	115		dB
	Channel-to-Channel Active Crosstalk	Alternating Conversions with 18V_{P-P} 200Hz Sine in $\pm 10.24\text{V}$ Range, Crosstalk to Any Other Channel		-125		dB
	-3dB Input Bandwidth			6		MHz
	Aperture Delay			1		ns
	Aperture Delay Matching			150		ps
	Aperture Jitter			3		ps _{RMS}
	Transient Response	Full-Scale Step, 0.005% Settling		420		ns

INTERNAL REFERENCE CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 9)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{REFIN}	Internal Reference Output Voltage		2.043	2.048	2.053	V
	Internal Reference Temperature Coefficient	(Note 14)	●	5	20	ppm/ $^\circ\text{C}$
	Internal Reference Line Regulation	$V_{DD} = 4.75\text{V}$ to 5.25V		0.1		mV/V
	Internal Reference Output Impedance			20		k Ω
V_{REFIN}	REFIN Voltage Range	REFIN Overdriven (Note 7)	1.25		2.2	V

REFERENCE BUFFER CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 9)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{REFBUF}	Reference Buffer Output Voltage	REFIN Overdriven, $V_{\text{REFIN}} = 2.048\text{V}$	●	4.091	4.096	4.101	V
	REFBUF Voltage Range	REFBUF Overdriven (Notes 7, 15)	●	2.5		5	V
	REFBUF Input Impedance	$V_{\text{REFIN}} = 0\text{V}$, Buffer Disabled			13		k Ω
I_{REFBUF}	REFBUF Load Current	$V_{\text{REFBUF}} = 5\text{V}$, (Notes 15, 16) $V_{\text{REFBUF}} = 5\text{V}$, Acquisition or Nap Mode (Note 15)	●		0.93 0.39	1.2	mA mA

DIGITAL INPUTS AND DIGITAL OUTPUTS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 9)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
CMOS Digital Inputs and Outputs							
V_{IH}	High Level Input Voltage		●	$0.8 \cdot \text{OV}_{\text{DD}}$			V
V_{IL}	Low Level Input Voltage		●			$0.2 \cdot \text{OV}_{\text{DD}}$	V
I_{IN}	Digital Input Current	$V_{\text{IN}} = 0\text{V}$ to OV_{DD}	●	-10		10	μA
C_{IN}	Digital Input Capacitance				5		pF
V_{OH}	High Level Output Voltage	$I_{\text{OUT}} = -500\mu\text{A}$	●	$\text{OV}_{\text{DD}} - 0.2$			V
V_{OL}	Low Level Output Voltage	$I_{\text{OUT}} = 500\mu\text{A}$	●			0.2	V
I_{OZ}	Hi-Z Output Leakage Current	$V_{\text{OUT}} = 0\text{V}$ to OV_{DD}	●	-10		10	μA
I_{SOURCE}	Output Source Current	$V_{\text{OUT}} = 0\text{V}$			-50		mA
I_{SINK}	Output Sink Current	$V_{\text{OUT}} = \text{OV}_{\text{DD}}$			50		mA
LVDS Digital Inputs and Outputs							
V_{ID}	Differential Input Voltage		●	200	350	600	mV
R_{ID}	On-Chip Input Termination Resistance	$\overline{\text{CS}} = 0\text{V}$, $V_{\text{ICM}} = 1.2\text{V}$ $\overline{\text{CS}} = \text{OV}_{\text{DD}}$	●	90	106 10	125	Ω M Ω
V_{ICM}	Common-Mode Input Voltage		●	0.3	1.2	2.2	V
I_{ICM}	Common-Mode Input Current	$V_{\text{IN+}} = V_{\text{IN-}} = 0\text{V}$ to OV_{DD}	●	-10		10	μA
V_{OD}	Differential Output Voltage	$R_{\text{L}} = 100\Omega$ Differential Termination	●	275	350	425	mV
V_{OCM}	Common-Mode Output Voltage	$R_{\text{L}} = 100\Omega$ Differential Termination	●	1.1	1.2	1.3	V
I_{OZ}	Hi-Z Output Leakage Current	$V_{\text{OUT}} = 0\text{V}$ to OV_{DD}	●	-10		10	μA

POWER REQUIREMENTS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 9)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{CC}	Supply Voltage		●	7.5		38	V
V_{EE}	Supply Voltage		●	-16.5		0	V
$V_{CC} - V_{EE}$	Supply Voltage Difference		●	10		38	V
V_{DD}	Supply Voltage		●	4.75	5.00	5.25	V
I_{VCC}	Supply Current	800ksps Sample Rate (Note 17)	●		7.2	7.7	mA
		Acquisition Mode (Note 17)	●		8.4	9.1	mA
		Nap Mode	●		2.9	3.3	mA
		Power Down Mode	●		6	15	μA
I_{VEE}	Supply Current	800ksps Sample Rate (Note 17)	●	-7.6	-6.7		mA
		Acquisition Mode (Note 17)	●	-9.2	-8.1		mA
		Nap Mode	●	-3.5	-2.8		mA
		Power Down Mode	●	-15	-4		μA

CMOS I/O Mode

OV_{DD}	Supply Voltage		●	1.71		5.25	V
I_{VDD}	Supply Current	800ksps Sample Rate	●		10.6	11.9	mA
		800ksps Sample Rate, $V_{REFBUF} = 5\text{V}$ (Note 15)	●		9.4	10.7	mA
		Acquisition Mode	●		2.1	2.7	mA
		Nap Mode	●		1.7	2.4	mA
		Power Down Mode (C-Grade and I-Grade)	●		106	275	μA
		Power Down Mode (H-Grade)	●		106	550	μA
I_{OVDD}	Supply Current	800ksps Sample Rate ($C_L = 25\text{pF}$)	●		2.4	2.9	mA
		Acquisition or Nap Mode	●		1	20	μA
		Power Down Mode	●		1	20	μA
P_D	Power Dissipation	800ksps Sample Rate (Note 17)	●		268	296	mW
		Acquisition Mode (Note 17)	●		258	288	mW
		Nap Mode	●		94	114	mW
		Power Down Mode (C-Grade and I-Grade)	●		0.68	1.9	mW
		Power Down Mode (H-Grade)	●		0.68	3.3	mW

LVDS I/O Mode

OV_{DD}	Supply Voltage		●	2.375		5.25	V
I_{VDD}	Supply Current	800ksps Sample Rate	●		13.4	14.5	mA
		800ksps Sample Rate, $V_{REFBUF} = 5\text{V}$ (Note 15)	●		12.2	13.7	mA
		Acquisition Mode	●		3.7	4.5	mA
		Nap Mode	●		3.4	4.1	mA
		Power Down Mode (C-Grade and I-Grade)	●		106	275	μA
		Power Down Mode (H-Grade)	●		106	550	μA
I_{OVDD}	Supply Current	800ksps Sample Rate, ($R_L = 100\Omega$)	●		7	8.8	mA
		Acquisition or Nap Mode ($R_L = 100\Omega$)	●		7	8.3	mA
		Power Down Mode	●		1	20	μA
P_D	Power Dissipation	800ksps Sample Rate (Note 17)	●		293	324	mW
		Acquisition Mode (Note 17)	●		284	318	mW
		Nap Mode	●		120	143	mW
		Power Down Mode (C-Grade and I-Grade)	●		0.68	1.9	mW
		Power Down Mode (H-Grade)	●		0.68	3.3	mW

ADC TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. (Note 9)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
f_{SMPL}	Maximum Sampling Frequency		●			800	ksps
t_{CYC}	Time Between Conversions		●	1.25			μs
t_{CONV}	Conversion Time		●	450	500	550	ns
t_{ACQ}	Acquisition Time	$(t_{\text{ACQ}} = t_{\text{CYC}} - t_{\text{CONV}} - t_{\text{BUSY}})$	●	670	730		ns
t_{CNVH}	CNV High Time		●	40			ns
t_{CNVL}	CNV Low Time		●	750			ns
$t_{\text{BUSY}}^{\text{LH}}$	CNV \uparrow to BUSY Delay	$C_L = 25\text{pF}$	●			30	ns
t_{QUIET}	Digital I/O Quiet Time from CNV \uparrow		●	20			ns
t_{PDH}	PD High Time		●	40			ns
t_{PDL}	PD Low Time		●	40			ns
t_{WAKE}	REFBUF Wake-Up Time	$C_{\text{REFBUF}} = 47\mu\text{F}$, $C_{\text{REFIN}} = 0.1\mu\text{F}$			200		ms

CMOS I/O Mode

t_{SCKI}	SCKI Period	(Notes 18, 19)	●	10			ns
t_{SCKIH}	SCKI High Time		●	4			ns
t_{SCKIL}	SCKI Low Time		●	4			ns
t_{SSDISCKI}	SDI Setup Time from SCKI \uparrow	(Note 18)	●	2			ns
t_{HSDISCKI}	SDI Hold Time from SCKI \uparrow	(Note 18)	●	1			ns
t_{DSDOSCKI}	SDO Data Valid Delay from SCKI \uparrow	$C_L = 25\text{pF}$ (Note 18)	●			7.5	ns
t_{HSDOSCKI}	SDO Remains Valid Delay from SCKI \uparrow	$C_L = 25\text{pF}$ (Note 18)	●	1.5			ns
t_{SKEW}	SDO to SCKO Skew	(Note 18)	●	-1	0	1	ns
$t_{\text{DSDOBUSYL}}$	SDO Data Valid Delay from BUSY \downarrow	$C_L = 25\text{pF}$ (Note 18)	●	0			ns
t_{EN}	Bus Enable Time After $\overline{\text{CS}}\downarrow$	(Note 18)	●			15	ns
t_{DIS}	Bus Relinquish Time After $\overline{\text{CS}}\uparrow$	(Note 18)	●			15	ns

LVDS I/O Mode

t_{SCKI}	SCKI Period	(Note 20)	●	4			ns
t_{SCKIH}	SCKI High Time	(Note 20)	●	1.5			ns
t_{SCKIL}	SCKI Low Time	(Note 20)	●	1.5			ns
t_{SSDISCKI}	SDI Setup Time from SCKI	(Notes 11, 20)	●	1.2			ns
t_{HSDISCKI}	SDI Hold Time from SCKI	(Notes 11, 20)	●	-0.2			ns
t_{DSDOSCKI}	SDO Data Valid Delay from SCKI	(Notes 11, 20)	●			6	ns
t_{HSDOSCKI}	SDO Remains Valid Delay from SCKI	(Notes 11, 20)	●	1			ns
t_{SKEW}	SDO to SCKO Skew	(Note 11)	●	-0.4	0	0.4	ns
$t_{\text{DSDOBUSYL}}$	SDO Data Valid Delay from BUSY \downarrow	(Note 11)	●	0			ns
t_{EN}	Bus Enable Time After $\overline{\text{CS}}\downarrow$		●			50	ns
t_{DIS}	Bus Relinquish Time After $\overline{\text{CS}}\uparrow$		●			15	ns

ADC TIMING CHARACTERISTICS

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: All voltage values are with respect to GND.

Note 3: V_{DDLBP} is the output of an internal voltage regulator, and should only be connected to a 2.2 μ F ceramic capacitor to bypass the pin to GND, as described in the Pin Functions section. Do not connect this pin to any external circuitry.

Note 4: When these pin voltages are taken below V_{EE} or above V_{CC} , they will be clamped by internal diodes. This product can handle input currents of up to 100mA below V_{EE} or above V_{CC} without latchup.

Note 5: When these pin voltages are taken below GND or above V_{DD} or OV_{DD} , they will be clamped by internal diodes. This product can handle currents of up to 100mA below GND or above V_{DD} or OV_{DD} without latchup.

Note 6: $-16.5V \leq V_{EE} \leq 0V$, $7.5V \leq V_{CC} \leq 38V$, $10V \leq (V_{CC} - V_{EE}) \leq 38V$, $V_{DD} = 5V$, unless otherwise specified.

Note 7: Recommended operating conditions.

Note 8: Exceeding these limits on any channel may corrupt conversion results on other channels. Driving an analog input above V_{CC} on any channel up to 10mA will not affect conversion results on other channels. Driving an analog input below V_{EE} may corrupt conversion results on other channels. Refer to Applications Information section for further details. Refer to Absolute Maximum Ratings section for pin voltage limits related to device reliability.

Note 9: $V_{CC} = 15V$, $V_{EE} = -15V$, $V_{DD} = 5V$, $OV_{DD} = 2.5V$, $f_{SAMPL} = 800k$ sps, internal reference and buffer, true bipolar input signal drive in bipolar SoftSpan ranges, unipolar signal drive in unipolar SoftSpan ranges, unless otherwise specified.

Note 10: Integral nonlinearity is defined as the deviation of a code from a straight line passing through the actual endpoints of the transfer curve. The deviation is measured from the center of the quantization band.

Note 11: Guaranteed by design, not subject to test.

Note 12: For bipolar SoftSpan ranges 7, 6, 3, and 2, zero-scale error is the offset voltage measured from $-0.5LSB$ when the output code flickers between 0000 0000 0000 0000 and 1111 1111 1111 1111. Full-scale error for these SoftSpan ranges is the worst-case deviation of the first and last code transitions from ideal and includes the effect of offset error. For unipolar SoftSpan ranges 5, 4, 1, and 0, zero-scale error is the offset voltage measured from $0.5LSB$ when the output code flickers between 0000 0000 0000 0000 and 0000 0000 0000 0001. Full-scale error for these SoftSpan ranges is the worst-case deviation of the last code transition from ideal and includes the effect of offset error.

Note 13: All specifications in dB are referred to a full-scale input in the relevant SoftSpan input range, except for crosstalk, which is referred to the crosstalk injection signal amplitude.

Note 14: Temperature coefficient is calculated by dividing the maximum change in output voltage by the specified temperature range.

Note 15: When REFBUF is overdriven, the internal reference buffer must be disabled by setting $REFIN = 0V$.

Note 16: I_{REFBUF} varies proportionally with sample rate.

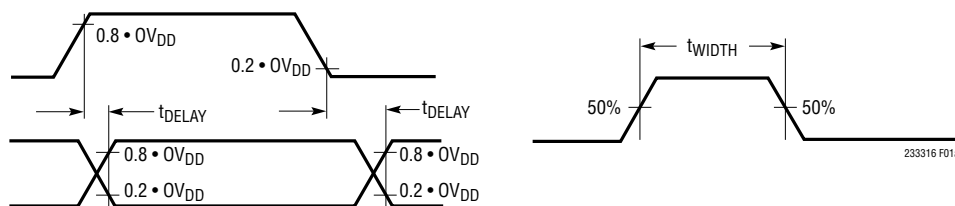
Note 17: Analog input buffer supply currents from I_{VCC} and I_{VEE} are reduced outside the acquisition period. Refer to nap mode in Applications Information section.

Note 18: Parameter tested and guaranteed at $OV_{DD} = 1.71V$, $OV_{DD} = 2.5V$, and $OV_{DD} = 5.25V$.

Note 19: A t_{SCKI} period of 10ns minimum allows a shift clock frequency of up to 100MHz for rising edge capture.

Note 20: $V_{ICM} = 1.2V$, $V_{ID} = 350mV$ for LVDS differential input pairs.

CMOS Timing



LVDS Timing (Differential)

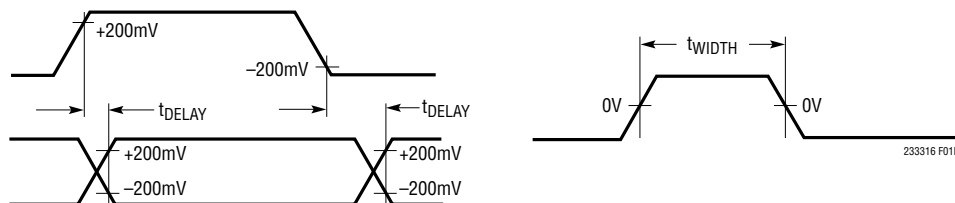
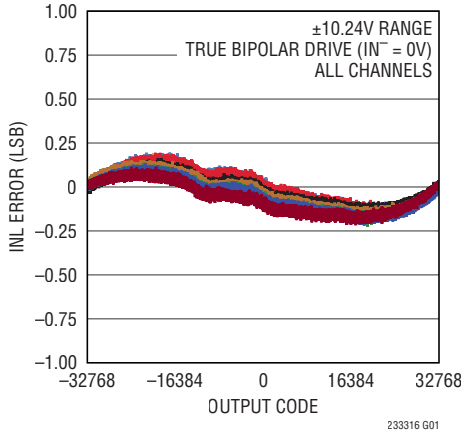


Figure 1. Voltage Levels for Timing Specifications

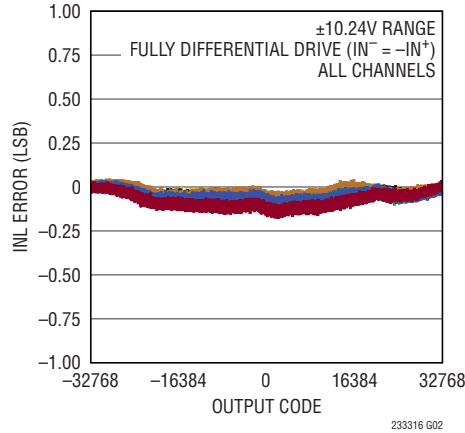
TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = 25^\circ\text{C}$, $V_{CC} = +15\text{V}$, $V_{EE} = -15\text{V}$, $V_{DD} = 5\text{V}$, $0V_{DD} = 2.5\text{V}$, Internal Reference and Buffer ($V_{REFBUF} = 4.096\text{V}$), $f_{SAMPL} = 800\text{ksps}$, unless otherwise noted.

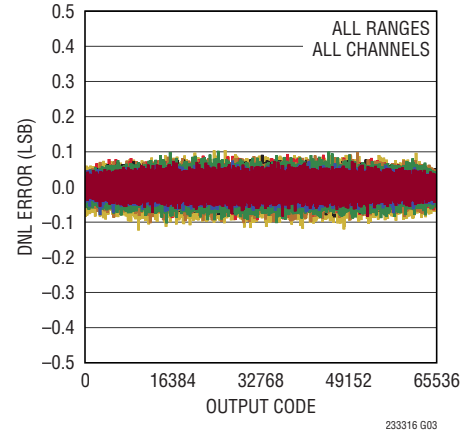
Integral Nonlinearity vs Output Code and Channel



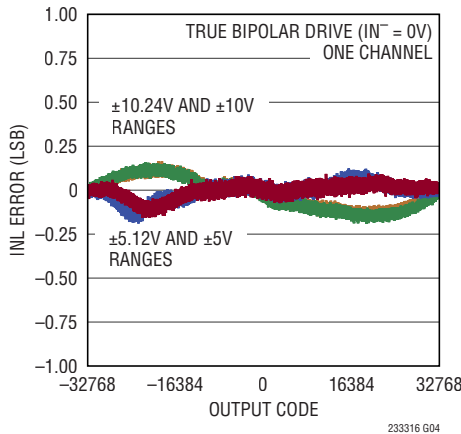
Integral Nonlinearity vs Output Code and Channel



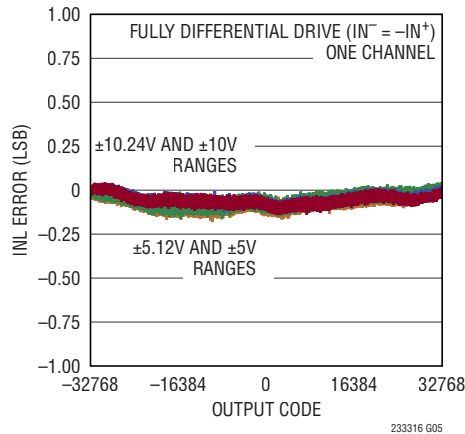
Differential Nonlinearity vs Output Code and Range



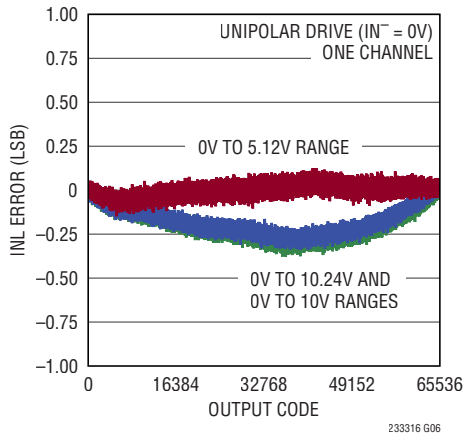
Integral Nonlinearity vs Output Code and Range



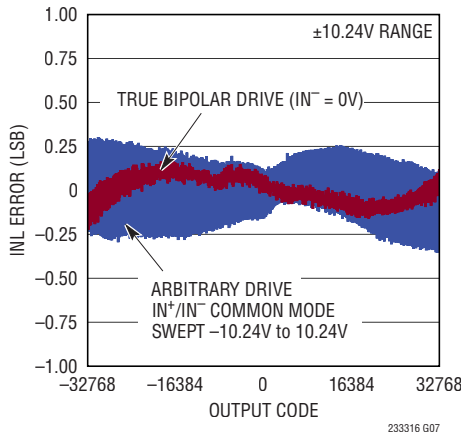
Integral Nonlinearity vs Output Code and Range



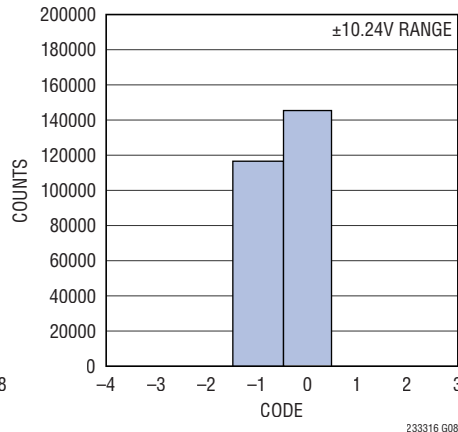
Integral Nonlinearity vs Output Code and Range



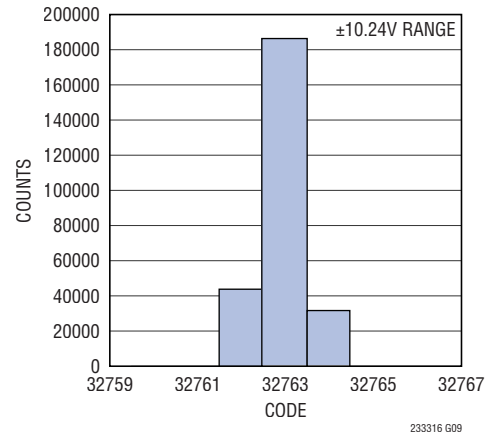
Integral Nonlinearity vs Output Code



DC Histogram (Zero-Scale)



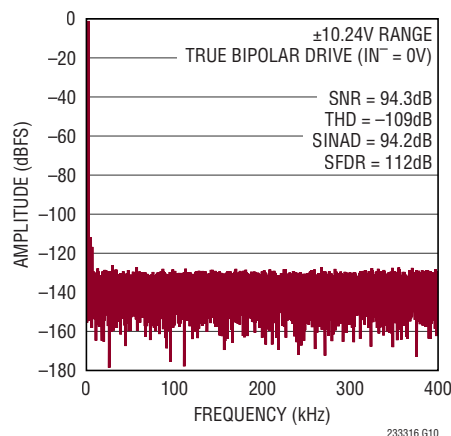
DC Histogram (Near Full-Scale)



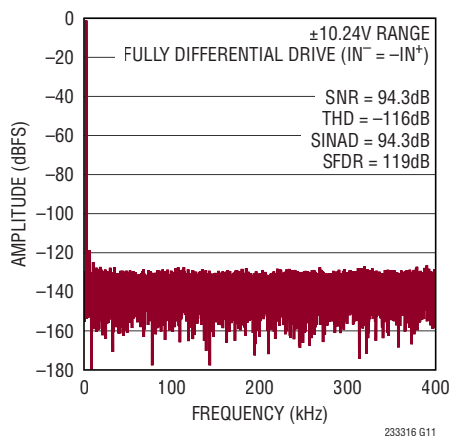
TYPICAL PERFORMANCE CHARACTERISTICS

$T_A = 25^\circ\text{C}$, $V_{CC} = +15\text{V}$, $V_{EE} = -15\text{V}$, $V_{DD} = 5\text{V}$, $0V_{DD} = 2.5\text{V}$, Internal Reference and Buffer ($V_{REFBUF} = 4.096\text{V}$), $f_{SMPL} = 800\text{ksps}$, unless otherwise noted.

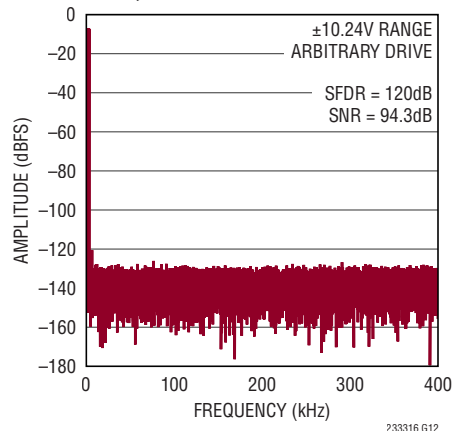
32k Point FFT $f_{SMPL} = 800\text{ksps}$,
 $f_{IN} = 2\text{kHz}$



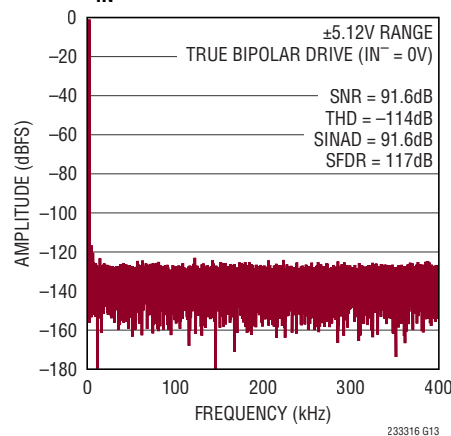
32k Point FFT $f_{SMPL} = 800\text{ksps}$,
 $f_{IN} = 2\text{kHz}$



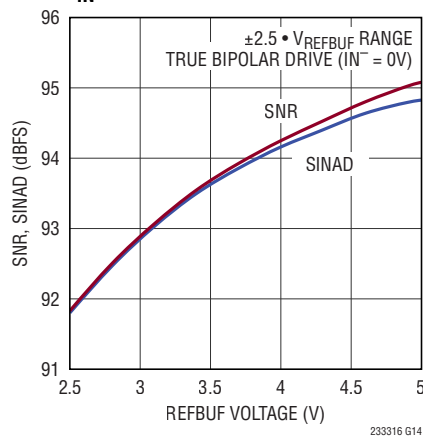
32k Point Arbitrary Two-Tone FFT
 $f_{SMPL} = 800\text{ksps}$, $IN^+ = -7\text{dBFS}$ 2kHz
Sine, $IN^- = -7\text{dBFS}$ 3.1kHz Sine



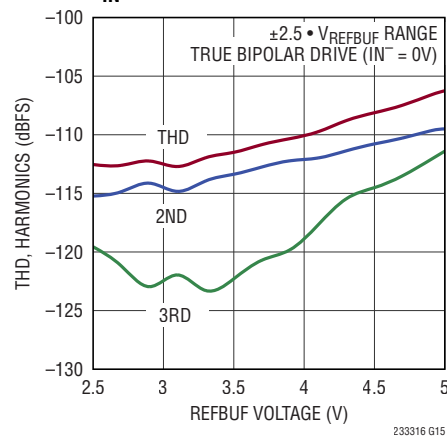
32k Point FFT $f_{SMPL} = 800\text{ksps}$,
 $f_{IN} = 2\text{kHz}$



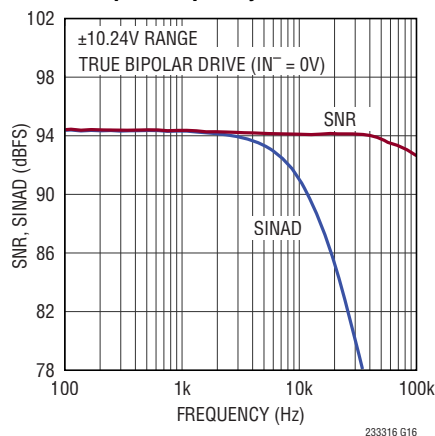
SNR, SINAD vs V_{REFBUF} ,
 $f_{IN} = 2\text{kHz}$



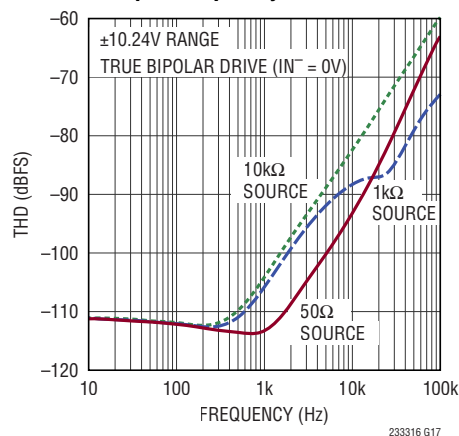
THD, Harmonics vs V_{REFBUF} ,
 $f_{IN} = 2\text{kHz}$



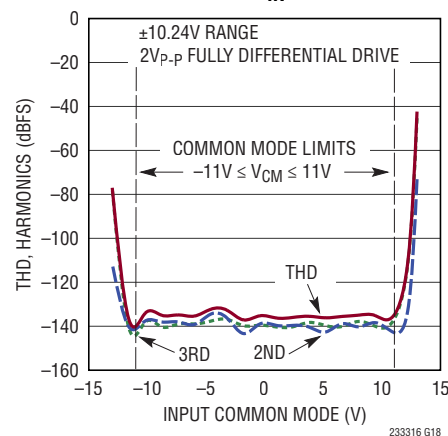
SNR, SINAD
vs Input Frequency



THD, Harmonics
vs Input Frequency



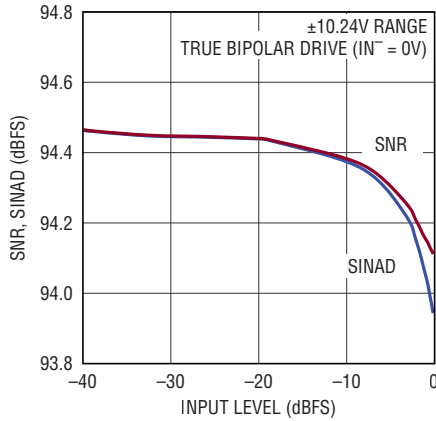
THD, Harmonics vs Input
Common Mode, $f_{IN} = 2\text{kHz}$



TYPICAL PERFORMANCE CHARACTERISTICS

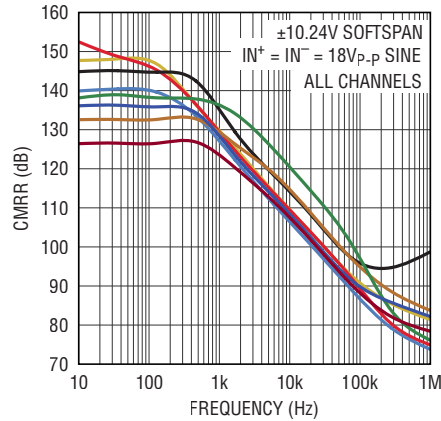
$T_A = 25^\circ\text{C}$, $V_{CC} = +15\text{V}$, $V_{EE} = -15\text{V}$, $V_{DD} = 5\text{V}$, $0V_{DD} = 2.5\text{V}$, Internal Reference and Buffer ($V_{REFBUF} = 4.096\text{V}$), $f_{SAMPL} = 800\text{ksps}$, unless otherwise noted.

SNR, SINAD vs Input Level,
 $f_{IN} = 2\text{kHz}$



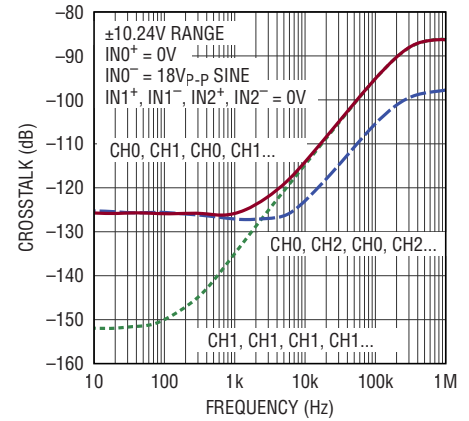
233316 G19

CMRR vs Input Frequency and Channel



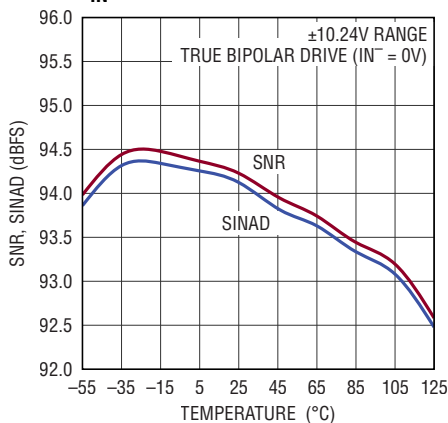
233316 G20

Crosstalk vs Input Frequency and Conversion Sequence



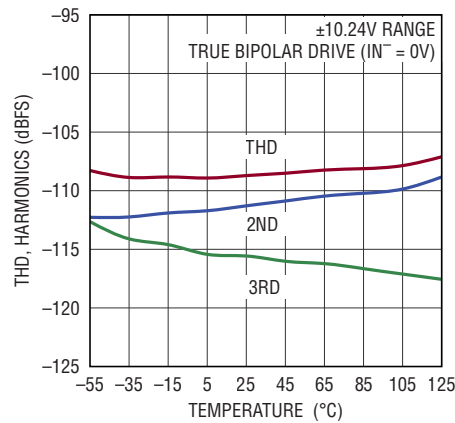
233316 G21

SNR, SINAD vs Temperature,
 $f_{IN} = 2\text{kHz}$



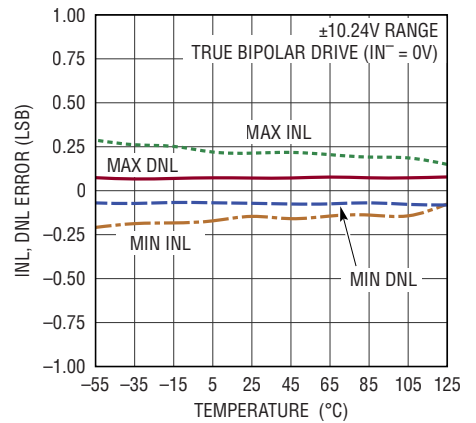
233316 G22

THD, Harmonics vs Temperature,
 $f_{IN} = 2\text{kHz}$



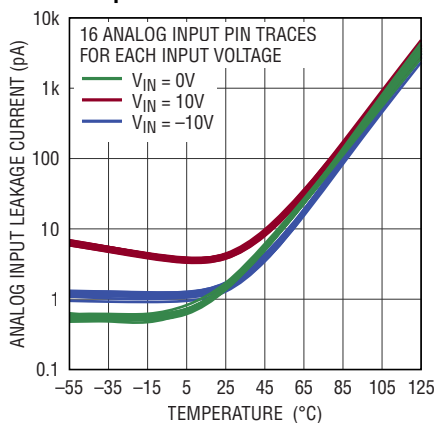
233316 G23

INL, DNL vs Temperature



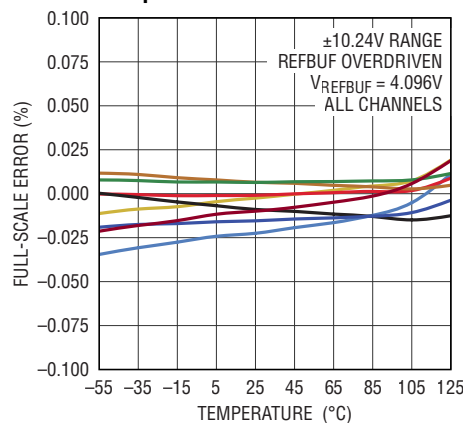
233316 G24

Analog Input Leakage Current vs Temperature



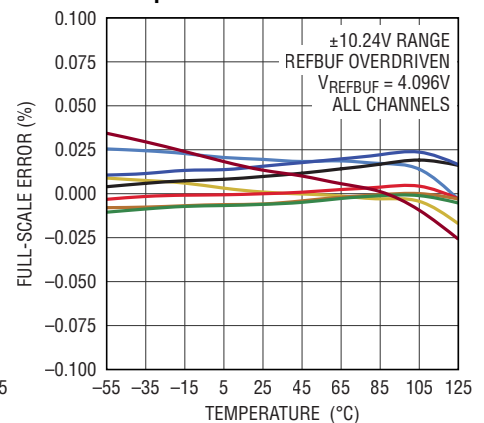
233316 G25

Positive Full-Scale Error vs Temperature and Channel



233316 G26

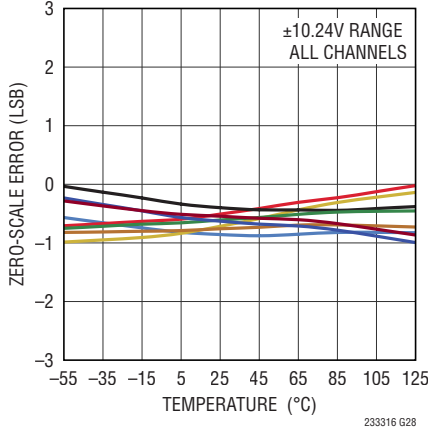
Negative Full-Scale Error vs Temperature and Channel



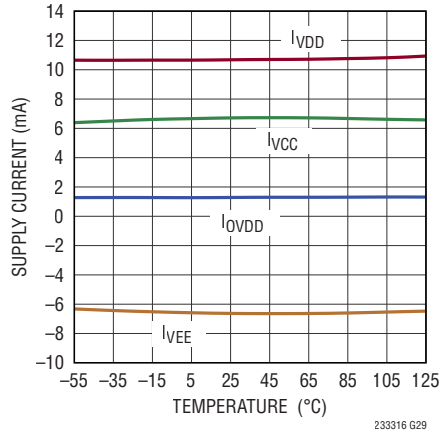
233316 G27

TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, $V_{CC} = +15\text{V}$, $V_{EE} = -15\text{V}$, $V_{DD} = 5\text{V}$, $0V_{DD} = 2.5\text{V}$, Internal Reference and Buffer ($V_{REFBUF} = 4.096\text{V}$), $f_{SAMPL} = 800\text{ksps}$, unless otherwise noted.

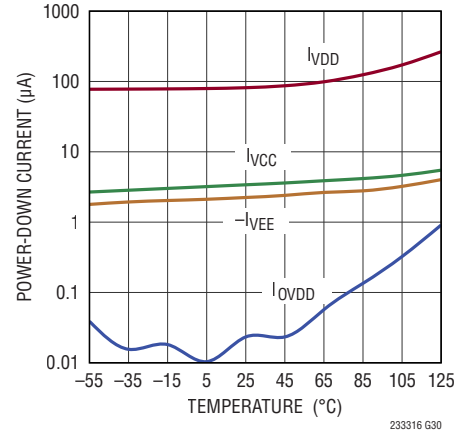
Zero-Scale Error vs Temperature and Channel



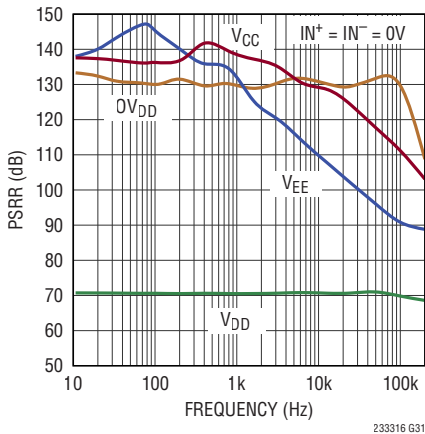
Supply Current vs Temperature



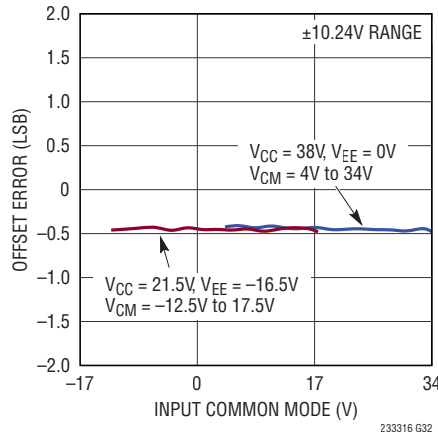
Power-Down Current vs Temperature



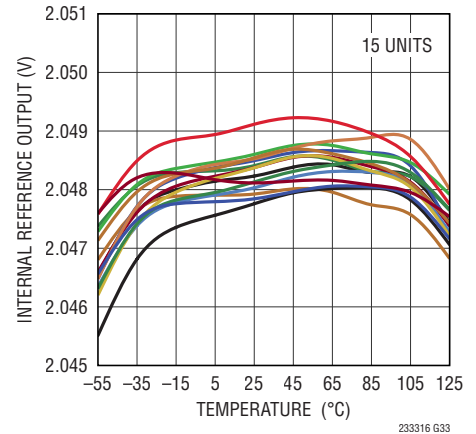
PSRR vs Frequency



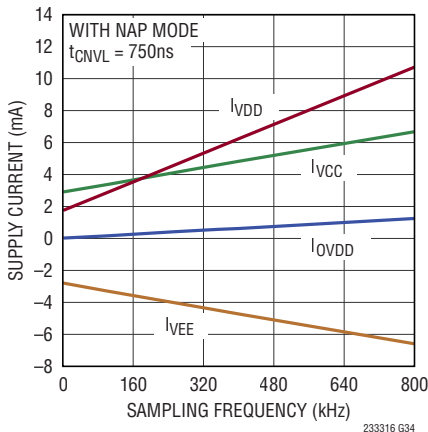
Offset Error vs Input Common Mode



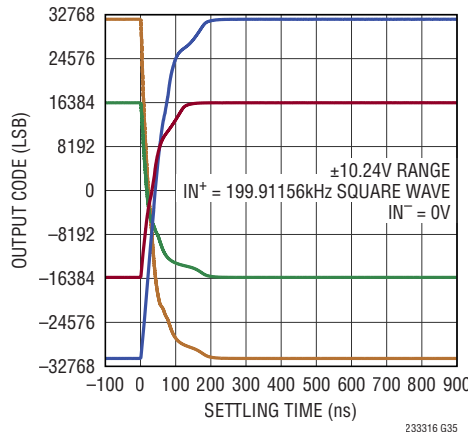
Internal Reference Output vs Temperature



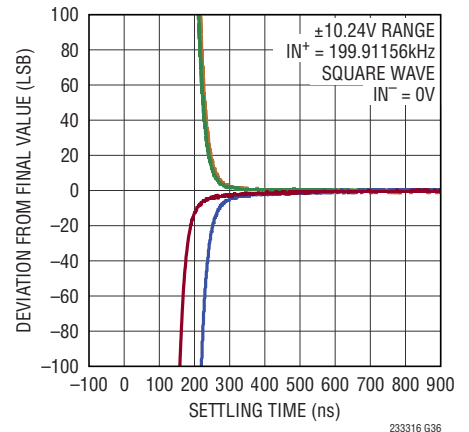
Supply Current vs Sampling Rate



Step Response (Large-Signal Settling)



Step Response (Fine Settling)



PIN FUNCTIONS

Pins that are the Same for All Digital I/O Modes

IN0⁺/IN0⁻ to IN7⁺/IN7⁻ (Pins 14/13, 12/11, 10/9, 8/7, 6/5, 4/3, 2/1, and 48/47): Positive and Negative Analog Inputs, Channels 0 to 7. The converter samples ($V_{IN+} - V_{IN-}$) and digitizes the selected channel. Wide input common mode range ($V_{EE} + 4V \leq V_{CM} \leq V_{CC} - 4V$) and high common mode rejection allow the inputs to accept a wide variety of signal swings. Full-scale input range is determined by the selected SoftSpan configuration.

GND (Pins 15, 18, 20, 25, 30, 36, 41, 44, 46): Ground. Solder all GND pins to a solid ground plane.

V_{CC} (Pin 16): Positive High Voltage Power Supply. The range of V_{CC} is 7.5V to 38V with respect to GND and 10V to 38V with respect to V_{EE} . Bypass V_{CC} to GND close to the pin with a 0.1 μ F ceramic capacitor.

V_{EE} (Pins 17, 45): Negative High Voltage Power Supply. The range of V_{EE} is 0V to -16.5V with respect to GND and -10V to -38V with respect to V_{CC} . Connect Pins 17 and 45 together and bypass the V_{EE} network to GND close to Pin 17 with a 0.1 μ F ceramic capacitor. In applications where V_{EE} is shorted to GND, this capacitor may be omitted.

REFIN (Pin 19): Bandgap Reference Output/Reference Buffer Input. An internal bandgap reference nominally outputs 2.048V on this pin. An internal reference buffer amplifies V_{REFIN} to create the converter master reference voltage $V_{REFBUF} = 2 \cdot V_{REFIN}$ on the REFBUF pin. When using the internal reference, bypass REFIN to GND (Pin 20) close to the pin with a 0.1 μ F ceramic capacitor to filter the bandgap output noise. If more accuracy is desired, overdrive REFIN with an external reference in the range of 1.25V to 2.2V. Do not load this pin when internal reference is used.

REFBUF (Pin 21): Internal Reference Buffer Output. An internal reference buffer amplifies V_{REFIN} to create the converter master reference voltage $V_{REFBUF} = 2 \cdot V_{REFIN}$ on this pin, nominally 4.096V when using the internal bandgap reference. Bypass REFBUF to GND (Pin 20) close to the pin with a 47 μ F ceramic capacitor. The internal reference buffer may be disabled by grounding its input

at REFIN. With the buffer disabled, overdrive REFBUF with an external reference voltage in the range of 2.5V to 5V. When using the internal reference buffer, limit the loading of any external circuitry connected to REFBUF to less than 200 μ A. Using a high input impedance amplifier to buffer V_{REFBUF} to any external circuits is recommended.

PD (Pin 22): Power Down Input. When this pin is brought high, the LTC2333-16 is powered down and subsequent conversion requests are ignored. If this occurs during a conversion, the device powers down once the conversion completes. If this pin is brought high twice without an intervening conversion, an internal global reset is initiated, equivalent to a power-on-reset event. Logic levels are determined by OV_{DD} .

LVDS/CMOS (Pin 23): I/O Mode Select. Tie this pin to OV_{DD} to select LVDS I/O mode, or to ground to select CMOS I/O mode. Logic levels are determined by OV_{DD} .

CNV (Pin 24): Conversion Start Input. A rising edge on this pin puts the internal sample-and-holds into the hold mode and initiates a new conversion. CNV is not gated by \overline{CS} , allowing conversions to be initiated independent of the state of the serial I/O bus.

BUSY (Pin 38): Busy Output. The BUSY signal indicates that a conversion is in progress. This pin transitions low-to-high at the start of each conversion and stays high until the conversion is complete. Logic levels are determined by OV_{DD} .

V_{DDL}BYP (Pin 40): Internal 2.5V Regulator Bypass Pin. The voltage on this pin is generated via an internal regulator operating off of V_{DD} . This pin must be bypassed to GND close to the pin with a 2.2 μ F ceramic capacitor. Do not connect this pin to any external circuitry.

V_{DD} (Pins 42, 43): 5V Power Supply. The range of V_{DD} is 4.75V to 5.25V. Connect Pins 42 and 43 together and bypass the V_{DD} network to GND with a shared 0.1 μ F ceramic capacitor close to the pins.

PIN FUNCTIONS

CMOS I/O Mode

SDI⁺/SDI⁻, SCKI⁻, SDO⁺/SDO⁻ (Pins 26/27, 28, and 34/35): LVDS Inputs and Outputs. In CMOS I/O mode these pins are Hi-Z.

SCKI (Pin 29): CMOS Serial Clock Input. Drive SCKI with the serial I/O clock. SCKI rising edges latch serial data in on SDI and clock serial data out on SDO. For standard SPI bus operation, capture output data at the receiver on rising edges of SCKI. SCKI is allowed to idle either high or low. Logic levels are determined by OV_{DD}.

OV_{DD} (Pin 31): I/O Interface Power Supply. In CMOS I/O mode, the range of OV_{DD} is 1.71V to 5.25V. Bypass OV_{DD} to GND (Pin 30) close to the pin with a 0.1μF ceramic capacitor.

SCKO (Pin 32): CMOS Serial Clock Output. SCKI rising edges trigger transitions on SCKO that are skew-matched to the serial output data stream on SDO. The resulting SCKO frequency is half that of SCKI. Rising and falling edges of SCKO may be used to capture SDO data at the receiver (FPGA) in double data rate (DDR) fashion. For standard SPI bus operation, SCKO is not used and should be left unconnected. SCKO is forced low at the falling edge of BUSY. Logic levels are determined by OV_{DD}.

SDO (Pin 33): CMOS Serial Data Output. The most recent conversion result along with channel configuration information is clocked out onto the SDO pin on each rising edge of SCKI. Output data formatting is described in the Digital Interface section. Logic levels are determined by OV_{DD}.

SDI (Pin 37): CMOS Serial Data Input. Drive this pin with the desired MUX control words (see Table 1a), latched on the rising edges of SCKI. Hold SDI low while clocking SCKI to configure the next conversion according to the previously programmed sequence. Logic levels are determined by OV_{DD}.

\overline{CS} (Pin 39): Chip Select Input. The serial data I/O bus is enabled when \overline{CS} is low and is disabled and Hi-Z when \overline{CS} is high. \overline{CS} also gates the external shift clock, SCKI. Logic levels are determined by OV_{DD}.

LVDS I/O Mode

SDI⁺/SDI⁻ (Pins 26/27): LVDS Positive and Negative Serial Data Input. Differentially drive SDI⁺/SDI⁻ with the desired MUX control words (see Table 1a), latched on both the rising and falling edges of SCKI⁺/SCKI⁻. The SDI⁺/SDI⁻ input pair is internally terminated with a 100Ω differential resistor when \overline{CS} is low.

SCKI⁺/SCKI⁻ (Pins 28/29): LVDS Positive and Negative Serial Clock Input. Differentially drive SCKI⁺/SCKI⁻ with the serial I/O clock. SCKI⁺/SCKI⁻ rising and falling edges latch serial data in on SDI⁺/SDI⁻ and clock serial data out on SDO⁺/SDO⁻. Idle SCKI⁺/SCKI⁻ low, including when transitioning \overline{CS} . The SCKI⁺/SCKI⁻ input pair is internally terminated with a 100Ω differential resistor when \overline{CS} is low.

OV_{DD} (Pin 31): I/O Interface Power Supply. In LVDS I/O mode, the range of OV_{DD} is 2.375V to 5.25V. Bypass OV_{DD} to GND (Pin 30) close to the pin with a 0.1μF ceramic capacitor.

SCKO⁺/SCKO⁻ (Pins 32/33): LVDS Positive and Negative Serial Clock Output. SCKO⁺/SCKO⁻ outputs a copy of the input serial I/O clock received on SCKI⁺/SCKI⁻, skew-matched with the serial output data stream on SDO⁺/SDO⁻. Use the rising and falling edges of SCKO⁺/SCKO⁻ to capture SDO⁺/SDO⁻ data at the receiver (FPGA). The SCKO⁺/SCKO⁻ output pair must be differentially terminated with a 100Ω resistor at the receiver (FPGA).

SDO⁺/SDO⁻ (Pins 34/35): LVDS Positive and Negative Serial Data Output. The most recent conversion result along with channel configuration information is clocked out onto SDO⁺/SDO⁻ on both rising and falling edges of SCKI⁺/SCKI⁻. The SDO⁺/SDO⁻ output pair must be differentially terminated with a 100Ω resistor at the receiver (FPGA).

SDI (Pin 37): CMOS Serial Data Input. In LVDS I/O mode this pin is Hi-Z.

\overline{CS} (Pin 39): Chip Select Input. The serial data I/O bus is enabled when \overline{CS} is low, and is disabled and Hi-Z when \overline{CS} is high. \overline{CS} also gates the external shift clock, SCKI⁺/SCKI⁻. The internal 100Ω differential termination resistors on the SCKI⁺/SCKI⁻ and SDI⁺/SDI⁻ input pairs are disabled when \overline{CS} is high. Logic levels are determined by OV_{DD}.

CONFIGURATION TABLES

Table 1a. SoftSpan Configuration Table. Use This Table with Table 1b to Choose Binary SoftSpan Codes SS[2:0] Based on Desired Analog Input Range. Combine MUX Word Header (10) with Binary Channel Number and SoftSpan Code to Form MUX Control Word C[7:0]. Use Serial Interface to Program LTC2333-16 Sequencer as Shown in Figures 16 to 19

BINARY SoftSpan CODE SS[2:0]	ANALOG INPUT RANGE	FULL SCALE RANGE	BINARY FORMAT OF CONVERSION RESULT
111	$\pm 2.5 \cdot V_{\text{REFBUF}}$	$5 \cdot V_{\text{REFBUF}}$	Two's Complement
110	$\pm 2.5 \cdot V_{\text{REFBUF}}/1.024$	$5 \cdot V_{\text{REFBUF}}/1.024$	Two's Complement
101	0V to $2.5 \cdot V_{\text{REFBUF}}$	$2.5 \cdot V_{\text{REFBUF}}$	Straight Binary
100	0V to $2.5 \cdot V_{\text{REFBUF}}/1.024$	$2.5 \cdot V_{\text{REFBUF}}/1.024$	Straight Binary
011	$\pm 1.25 \cdot V_{\text{REFBUF}}$	$2.5 \cdot V_{\text{REFBUF}}$	Two's Complement
010	$\pm 1.25 \cdot V_{\text{REFBUF}}/1.024$	$2.5 \cdot V_{\text{REFBUF}}/1.024$	Two's Complement
001	0V to $1.25 \cdot V_{\text{REFBUF}}$	$1.25 \cdot V_{\text{REFBUF}}$	Straight Binary
000	0V to $1.25 \cdot V_{\text{REFBUF}}/1.024$	$1.25 \cdot V_{\text{REFBUF}}/1.024$	Straight Binary

Table 1b. Reference Configuration Table. The LTC2333-16 Supports Three Reference Configurations. Analog Input Range Scales with the Converter Master Reference Voltage, V_{REFBUF}

REFERENCE CONFIGURATION	V_{REFIN}	V_{REFBUF}	BINARY SoftSpan CODE SS[2:0]	ANALOG INPUT RANGE
Internal Reference with Internal Buffer	2.048V	4.096V	111	$\pm 10.24\text{V}$
			110	$\pm 10\text{V}$
			101	0V to 10.24V
			100	0V to 10V
			011	$\pm 5.12\text{V}$
			010	$\pm 5\text{V}$
			001	0V to 5.12V
			000	0V to 5V
External Reference with Internal Buffer (REFIN Pin Externally Overdriven)	1.25V (Min Value)	2.5V	111	$\pm 6.25\text{V}$
			110	$\pm 6.104\text{V}$
			101	0V to 6.25V
			100	0V to 6.104V
			011	$\pm 3.125\text{V}$
			010	$\pm 3.052\text{V}$
			001	0V to 3.125V
			000	0V to 3.052V
	2.2V (Max Value)	4.4V	111	$\pm 11\text{V}$
			110	$\pm 10.742\text{V}$
			101	0V to 11V
			100	0V to 10.742V
			011	$\pm 5.5\text{V}$
			010	$\pm 5.371\text{V}$
			001	0V to 5.5V
			000	0V to 5.371V

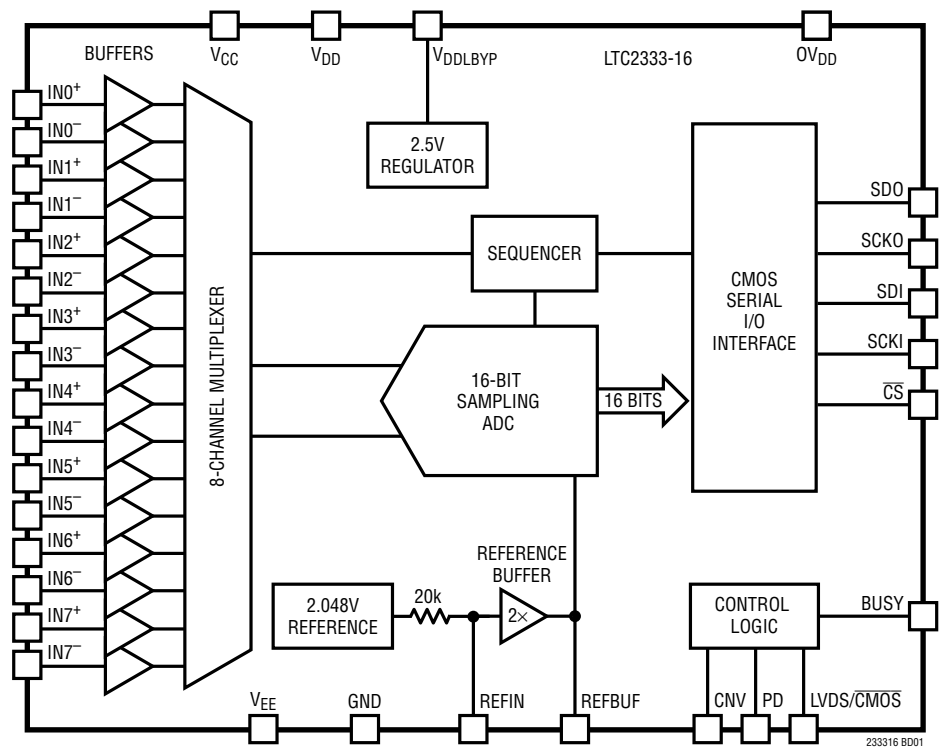
CONFIGURATION TABLES

Table 1b. Reference Configuration Table (Continued). The LTC2333-16 Supports Three Reference Configurations. Analog Input Range Scales with the Converter Master Reference Voltage, V_{REFBUF}

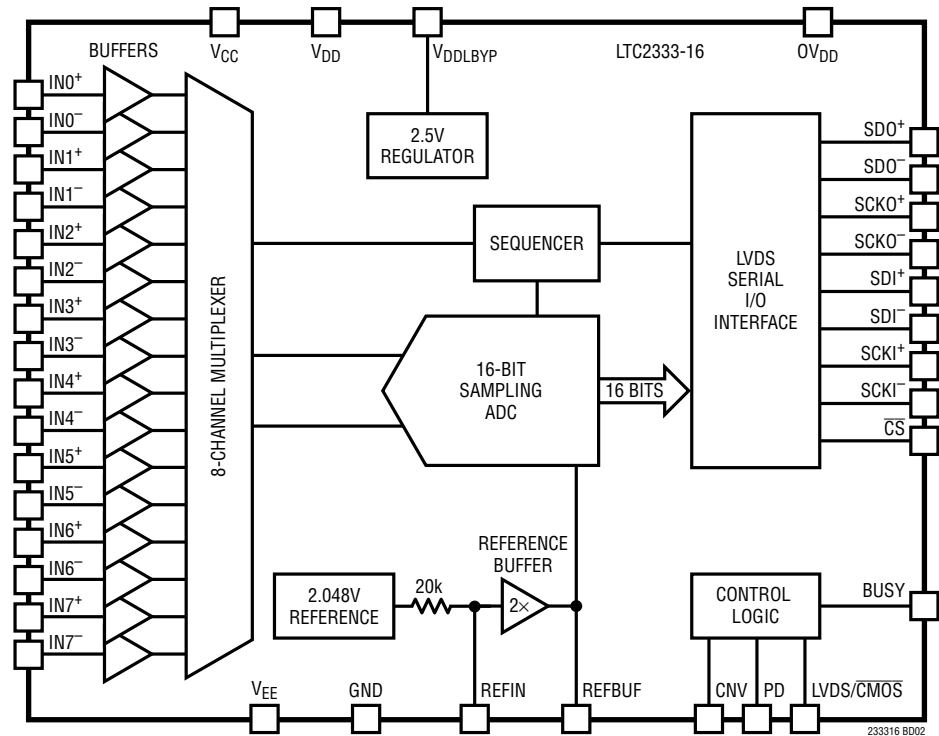
REFERENCE CONFIGURATION	V_{REFIN}	V_{REFBUF}	BINARY SoftSpan CODE SS[2:0]	ANALOG INPUT RANGE
External Reference Unbuffered (REFBUF Pin Externally Overdriven, REFIN Pin Grounded)	0V	2.5V (Min Value)	111	±6.25V
			110	±6.104V
			101	0V to 6.25V
			100	0V to 6.104V
			011	±3.125V
			010	±3.052V
			001	0V to 3.125V
			000	0V to 3.052V
	0V	5V (Max Value)	111	±12.5V
			110	±12.207V
			101	0V to 12.5V
			100	0V to 12.207V
			011	±6.25V
			010	±6.104V
			001	0V to 6.25V
			000	0V to 6.104V

FUNCTIONAL BLOCK DIAGRAM

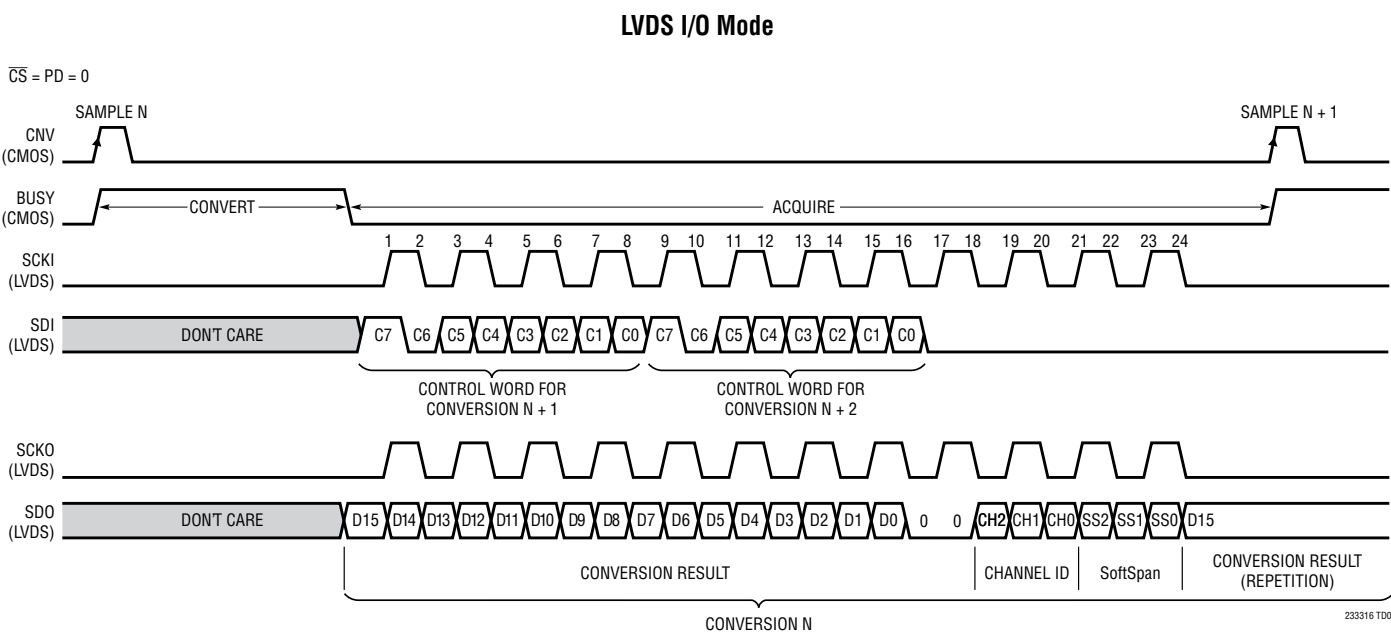
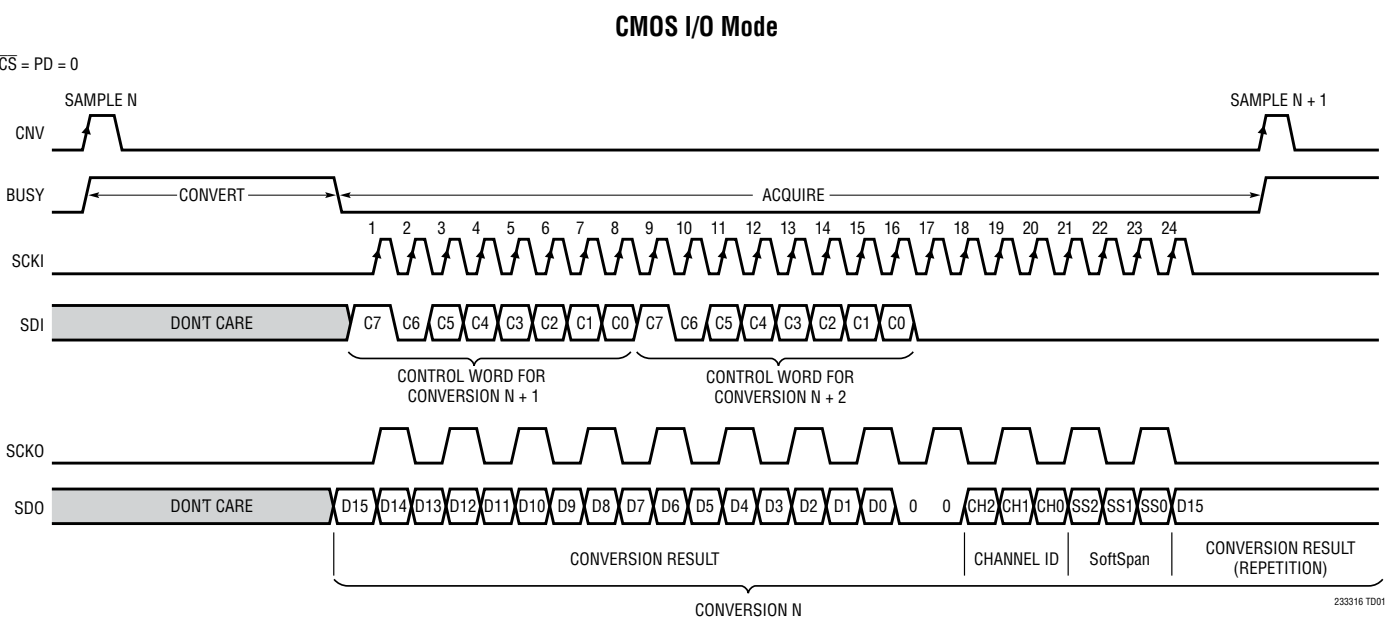
CMOS I/O Mode



LVDS I/O Mode



TIMING DIAGRAM



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OVERVIEW

The LTC2333-16 is a 16-bit, low noise 8-channel multiplexed successive approximation register (SAR) ADC with buffered differential, wide common mode range picoamp inputs. The ADC operates from a 5V low voltage supply and flexible high voltage supplies, nominally $\pm 15\text{V}$. Using the integrated low-drift reference and buffer ($V_{\text{REFBUF}} = 4.096\text{V}$ nominal), this SoftSpan ADC can be configured on a conversion-by-conversion basis to accept $\pm 10.24\text{V}$, 0V to 10.24V , $\pm 5.12\text{V}$, or 0V to 5.12V signals on any channel. Alternately, the ADC may be programmed to cycle through a sequence of channels and ranges without further user intervention. The input signal range may be expanded up to $\pm 12.5\text{V}$ using an external 5V reference.

The integrated picoamp-input analog buffers, wide input common mode range, and 128dB CMRR of the LTC2333-16 allow the ADC to directly digitize a variety of signals using minimal board space and power. This input signal flexibility, combined with $\pm 1\text{LSB}$ INL, no missing codes at 16-bits, and 94.2dB SNR, makes the LTC2333-16 an ideal choice for many high voltage applications requiring wide dynamic range.

The absolute common mode input range ($V_{\text{EE}} + 4\text{V}$ to $V_{\text{CC}} - 4\text{V}$) is determined by the choice of high voltage supplies. These supplies may be biased asymmetrically around ground and include the ability for V_{EE} to be tied directly to ground.

The LTC2333-16 supports pin-selectable SPI CMOS (1.8V to 5V) and LVDS serial interfaces, enabling it to communicate equally well with legacy microcontrollers and modern FPGAs. The LTC2333-16 typically dissipates 268mW when converting at 800ksps throughput. Optional nap and power down modes may be employed to further reduce power consumption during inactive periods.

CONVERTER OPERATION

The LTC2333-16 operates in two phases. During the acquisition phase, the sampling capacitors in each channel connect to their respective analog input pins and track the differential analog input voltage ($V_{\text{IN}+} - V_{\text{IN}-}$). A rising edge on the CNV pin transitions the S/H circuits from track mode to hold mode, sampling the input signals and initiating a conversion. During the conversion phase, the selected

channel's sampling capacitors are connected to a 16-bit charge redistribution capacitor D/A converter (CDAC). The CDAC is sequenced through a successive approximation algorithm, effectively comparing the sampled input voltage with binary-weighted fractions of the channel's SoftSpan full-scale range (e.g., $V_{\text{FSR}}/2$, $V_{\text{FSR}}/4 \dots V_{\text{FSR}}/65536$) using a differential comparator. At the end of this process, the CDAC output approximates the channel's sampled analog input. The ADC control logic then prepares the 16-bit digital output code for serial transfer.

TRANSFER FUNCTION

The LTC2333-16 digitizes the full-scale voltage range into 2^{16} levels. In conjunction with the ADC master reference voltage, V_{REFBUF} , the selected SoftSpan configuration determines its input voltage range, full-scale range, LSB size, and the binary format of its conversion result, as shown in Tables 1a and 1b. For example, employing the internal reference and buffer ($V_{\text{REFBUF}} = 4.096\text{V}$ nominal), SoftSpan 7 configures a channel to accept a $\pm 10.24\text{V}$ bipolar analog input voltage range, which corresponds to a 20.48V full-scale range with a $312.5\mu\text{V}$ LSB. Other SoftSpan configurations and reference voltages may be employed to convert both larger and smaller bipolar and unipolar input ranges. Conversion results are output in two's complement binary format for all bipolar SoftSpan ranges, and in straight binary format for all unipolar SoftSpan ranges. The ideal two's complement transfer function is shown in Figure 2, while the ideal straight binary transfer function is shown in Figure 3.

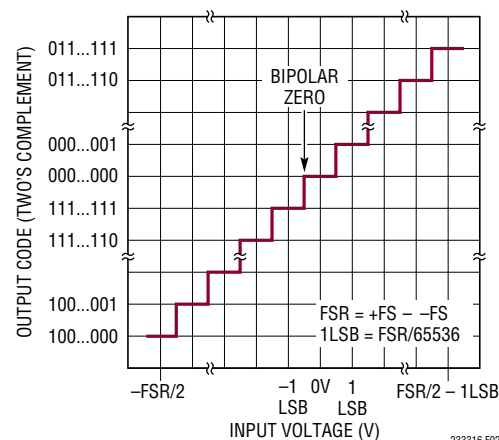


Figure 2. LTC2333-16 Two's Complement Transfer Function

233316f

APPLICATIONS INFORMATION

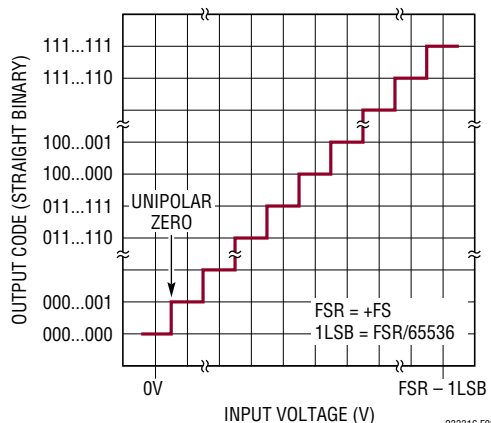


Figure 3. LTC2333-16 Straight Binary Transfer Function

BUFFERED ANALOG INPUTS

The LTC2333-16 samples the voltage difference ($V_{IN+} - V_{IN-}$) between its analog input pins over a wide common mode input range while attenuating unwanted signals common to both input pins by the common-mode rejection ratio (CMRR) of the ADC. Wide common mode input range coupled with high CMRR allows the IN^+ / IN^- analog inputs to swing with an arbitrary relationship to each other, provided each pin remains between ($V_{CC} - 4V$) and ($V_{EE} + 4V$). This feature of the LTC2333-16 enables it to accept a wide variety of signal swings, including traditional classes of analog input signals such as pseudo-differential unipolar, pseudo-differential true bipolar, and fully differential, simplifying signal chain design. For conversion of signals extending to V_{EE} , the unbuffered LTC2335-16 ADC is recommended.

The wide operating range of the high voltage supplies offers further input common mode flexibility. As long as the voltage difference limits of $10V \leq (V_{CC} - V_{EE}) \leq 38V$ are observed, V_{CC} and V_{EE} may be independently biased anywhere within their own individually allowed operating ranges, including the ability for V_{EE} to be tied directly to ground. This feature enables the common mode input range of the LTC2333-16 to be tailored to the specific application's requirements.

In all SoftSpan ranges, each channel's analog inputs can be modeled by the equivalent circuit shown in Figure 4. At the start of acquisition, the sampling capacitors (C_{SAMP})

connect to the integrated buffers $Buffer^+$ / $Buffer^-$ through the sampling switches. The sampled voltage is reset during the conversion process and is therefore re-acquired for each new conversion.

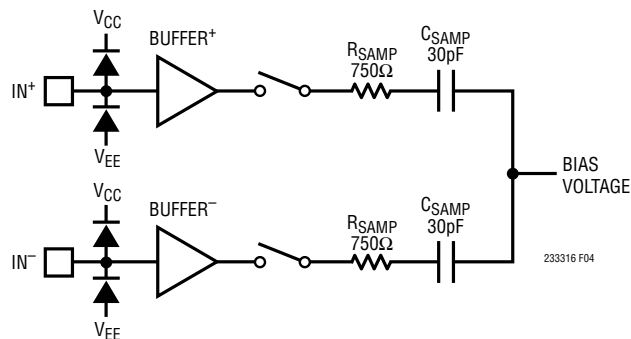


Figure 4. Equivalent Circuit for Differential Analog Inputs, Single Channel Shown

The diodes between the inputs and the V_{CC} and V_{EE} supplies provide input ESD protection. While within the supply voltages, the analog inputs of the LTC2333-16 draw only 5pA typical DC leakage current and the ESD protection diodes do not turn on. This offers a significant advantage over external op amp buffers, which often have diode protection that turns on during transients and corrupts the voltage on any filter capacitors at their inputs.

Bipolar SoftSpan Input Ranges

For conversions configured in SoftSpan ranges 7, 6, 3, or 2, the LTC2333-16 digitizes the differential analog input voltage ($V_{IN+} - V_{IN-}$) over a bipolar span of $\pm 2.5 \cdot V_{REFBUF}$, $\pm 2.5 \cdot V_{REFBUF}/1.024$, $\pm 1.25 \cdot V_{REFBUF}$, or $\pm 1.25 \cdot V_{REFBUF}/1.024$, respectively, as shown in Table 1a. These SoftSpan ranges are useful for digitizing input signals where IN^+ and IN^- swing above and below each other. Traditional examples include fully differential input signals, where IN^+ and IN^- are driven 180 degrees out-of-phase with respect to each other centered around a common mode voltage $(V_{IN+} + V_{IN-})/2$, and pseudo-differential true bipolar input signals, where IN^+ swings above and below a ground reference level, driven on IN^- . Regardless of the chosen SoftSpan range, the wide common mode

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input range and high CMRR of the IN^+/IN^- analog inputs allow them to swing with an arbitrary relationship to each other, provided each pin remains between $(V_{CC} - 4V)$ and $(V_{EE} + 4V)$. The output data format for all bipolar SoftSpan ranges is two's complement.

Unipolar SoftSpan Input Ranges

For conversions configured in SoftSpan ranges 5, 4, 1, or 0, the LTC2333-16 digitizes the differential analog input voltage ($V_{IN^+} - V_{IN^-}$) over a unipolar span of 0V to $2.5 \cdot V_{REFBUF}$, 0V to $2.5 \cdot V_{REFBUF}/1.024$, 0V to $1.25 \cdot V_{REFBUF}$, or 0V to $1.25 \cdot V_{REFBUF}/1.024$, respectively, as shown in Table 1a. These SoftSpan ranges are useful for digitizing input signals where IN^+ remains above IN^- . A traditional example includes pseudo-differential unipolar input signals, where IN^+ swings above a ground reference level, driven on IN^- . Regardless of the chosen SoftSpan range, the wide common mode input range and high CMRR of the IN^+/IN^- analog inputs allow them to swing with an arbitrary relationship to each other, provided each pin remains between $(V_{CC} - 4V)$ and $(V_{EE} + 4V)$. The output data format for all unipolar SoftSpan ranges is straight binary.

INPUT DRIVE CIRCUITS

The CMOS buffer input stage offers a very high degree of transient isolation from the sampling process. Most sensors, signal conditioning amplifiers and filter networks with less than $10k\Omega$ of impedance can drive the passive 3pF analog input capacitance directly. For higher impedances and slow-settling circuits, add a 680pF capacitor at the pins to maintain the full DC accuracy of the LTC2333-16.

The very high input impedance of the unity gain buffers in the LTC2333-16 greatly reduces the input drive requirements and makes it possible to include optional RC filters with $k\Omega$ impedance and arbitrarily slow time constants for anti-aliasing or other purposes. Micro-power op amps with limited drive capability are also well suited to drive the high impedance analog inputs directly.

The LTC2333-16 features proprietary circuitry to achieve exceptional internal crosstalk isolation between channels ($-125dB$ typical). The PC board wiring to the analog inputs should be short and shielded to prevent external capacitive crosstalk between channels. The capacitance between adjacent package pins is 0.16pF. Low source resistance and/or high source capacitance help reduce external capacitively coupled crosstalk. Single ended input drive also enjoys additional external crosstalk isolation because every other input pin is grounded, or at a low impedance DC source, and serves as a shield between channels.

Input Overdrive Tolerance

Driving an analog input above V_{CC} on any channel up to 10mA will not affect conversion results on other channels. Approximately 70% of this overdrive current will flow out of the V_{CC} pin and the remaining 30% will flow out of V_{EE} . This current flowing out of V_{EE} will produce heat across the $V_{CC}-V_{EE}$ voltage drop and must be taken into account for the total Absolute Maximum power dissipation of 500mW. Driving an analog input below V_{EE} may corrupt conversion results on other channels. This product can handle input currents of up to 100mA below V_{EE} or above V_{CC} without latchup. Keep in mind that driving the inputs above V_{CC} or below V_{EE} may reverse the normal current flow from the external power supplies driving these pins.

Input Filtering

The true high impedance analog inputs can accommodate a very wide range of passive or active signal conditioning filters. The buffered ADC inputs have an analog bandwidth of 6MHz, and impose no particular bandwidth requirement on external filters. The external input filters can therefore be optimized independent of the ADC to reduce signal chain noise and interference. A common filter configuration is the simple anti-aliasing and noise reducing RC filter with its pole at half the sampling frequency. For example,

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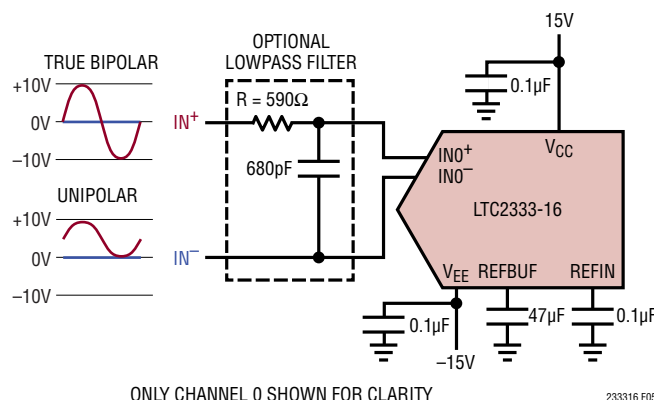


Figure 5. Filtering Single-Ended Input Signals

sampling one channel at 800ksps yields $R = 590\Omega$ and $C = 680\text{pF}$ as shown in Figure 5.

High quality capacitors and resistors should be used in the RC filters since these components can add distortion. NPO/COG and silver mica type dielectric capacitors have excellent linearity. Carbon surface mount resistors can generate distortion from self-heating and from damage that may occur during soldering. Metal film surface mount resistors are much less susceptible to both problems.

Arbitrary and Fully Differential Analog Input Signals

The wide common mode input range and high CMRR of the LTC2333-16 allow each channel's IN^+ and IN^- pins to swing with an arbitrary relationship to each other, provided each pin remains between $(V_{\text{CC}} - 4\text{V})$ and $(V_{\text{EE}} + 4\text{V})$. This feature of the LTC2333-16 enables it to accept a wide variety of signal swings, simplifying signal chain design.

The two-tone test shown in Figure 6b demonstrates the arbitrary input drive capability of the LTC2333-16. This test simultaneously drives IN^+ with a -7dBFS 2kHz single-ended sine wave and IN^- with a -7dBFS 3.1kHz single-ended sine wave. Together, these signals sweep the analog inputs across a wide range of common mode and differential mode voltage combinations, similar to the more general arbitrary input signal case. They also have a simple spectral representation. An ideal differential converter with no common-mode sensitivity will digitize this signal as two -7dBFS spectral tones, one at each sine wave frequency. The FFT plot in Figure 6b demonstrates the LTC2333-16 response, which approaches this ideal with 120dB of SFDR limited by the converter's second harmonic distortion response to the 3.1kHz sine wave on IN^- .

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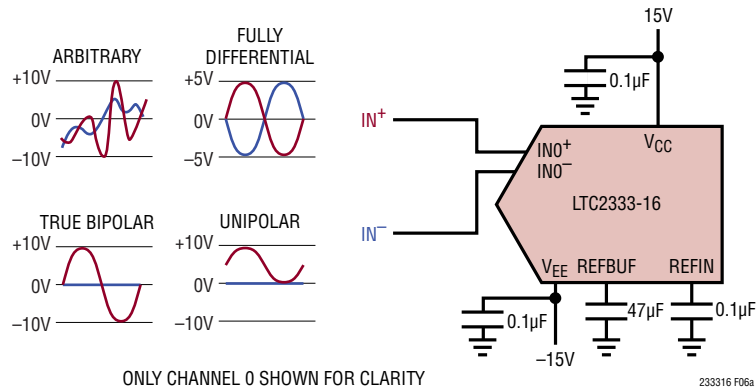
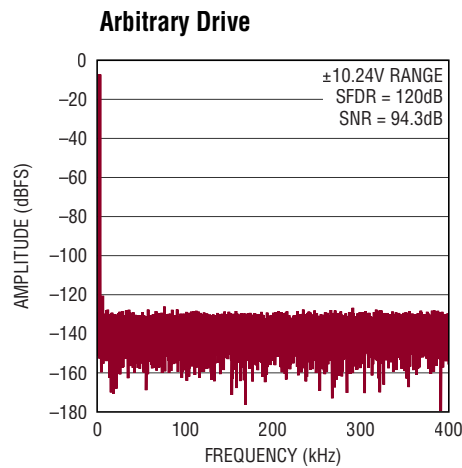
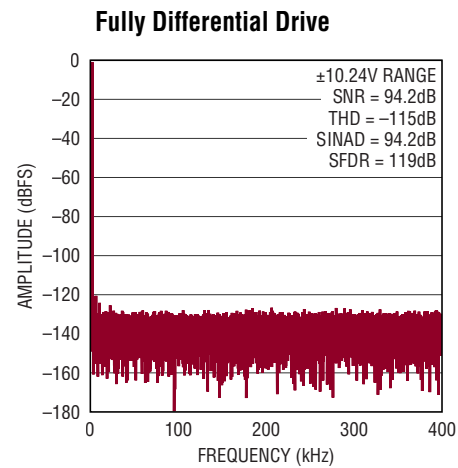
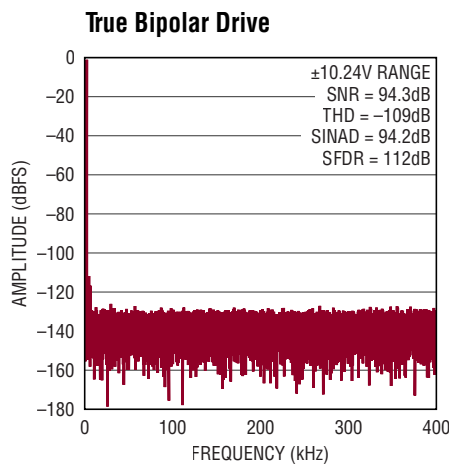
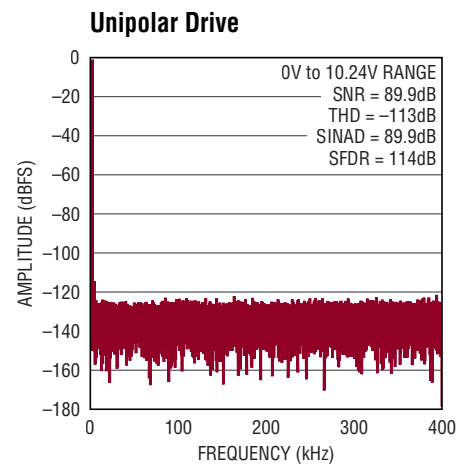


Figure 6a. Input Arbitrary, Fully Differential, True Bipolar, and Unipolar Signals

Figure 6b. Two-Tone Test. $IN^+ = -7\text{dBFS}$ 2kHz Sine, $IN^- = -7\text{dBFS}$ 3.1kHz Sine, 32k Point FFT, $f_{\text{SAMPL}} = 800\text{kps}$. Circuit Shown in Figure 6aFigure 6c. $IN^+/IN^- = -1\text{dBFS}$ 2kHz Fully Differential Sine, $V_{\text{CM}} = 0\text{V}$, 32k Point FFT, $f_{\text{SAMPL}} = 800\text{kps}$. Circuit Shown in Figure 6aFigure 6d. $IN^+ = -1\text{dBFS}$ 2kHz True Bipolar Sine, $IN^- = 0\text{V}$, 32k Point FFT, $f_{\text{SAMPL}} = 800\text{kps}$. Circuit Shown in Figure 6aFigure 6e. $IN^+ = -1\text{dBFS}$ 2kHz Unipolar Sine, $IN^- = 0\text{V}$, 32k Point FFT, $f_{\text{SAMPL}} = 800\text{kps}$. Circuit Shown in Figure 6a

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The ability of the LTC2333-16 to accept arbitrary signal swings over a wide input common mode range with high CMRR can simplify application solutions. In practice, many sensors produce a differential sensor voltage riding on top of a large common mode signal. Figure 7a depicts one way of using the LTC2333-16 to digitize signals of this type. The amplifier stage provides a differential gain of approximately 10V/V to the desired sensor signal while the unwanted common mode signal is attenuated by the ADC CMRR. The circuit employs the $\pm 5V$ SoftSpan range of the ADC. Figure 7b shows measured CMRR performance of this solution, which is competitive with the best commercially available instrumentation amplifiers. Figure 7c shows measured AC performance of this solution.

In Figure 8, another application circuit is shown which uses two channels of the LTC2333-16 to sense the voltage on and bidirectional current through a sense resistor over a wide common mode range.

ADC REFERENCE

As shown previously in Table 1b, the LTC2333-16 supports three reference configurations. The first uses both the internal bandgap reference and reference buffer. The second externally overdrives the internal reference but retains the internal buffer, which isolates the external reference from ADC conversion transients. This configuration is ideal for sharing a single precision external reference across multiple ADCs. The third disables the internal buffer and overdrives the REFBUF pin externally.

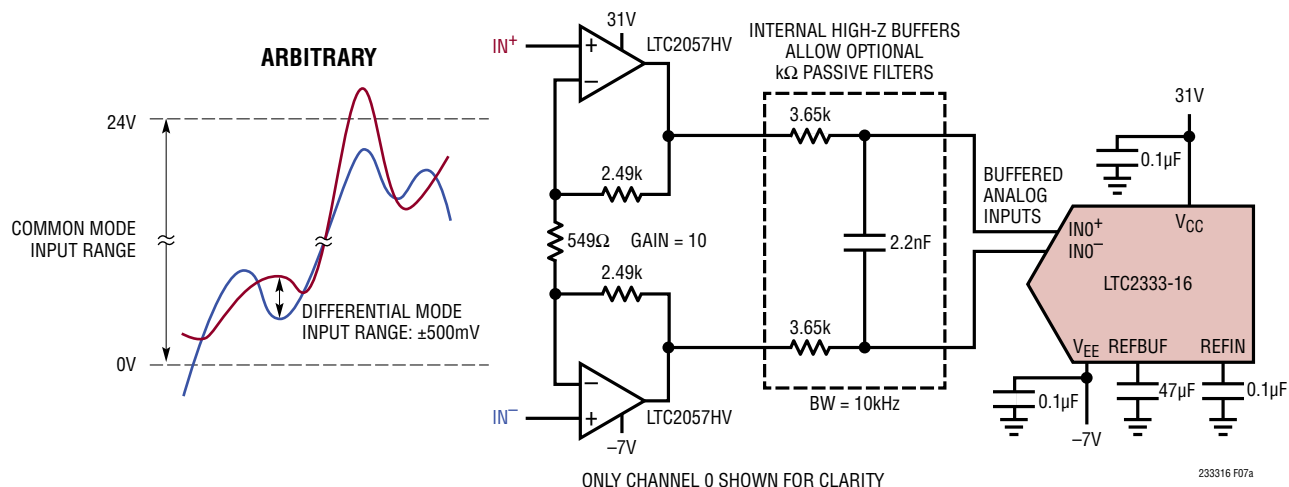


Figure 7a. Amplify Differential Signals with Gain of 10 Over a Wide Common Mode Range with Buffered Analog Inputs

APPLICATIONS INFORMATION

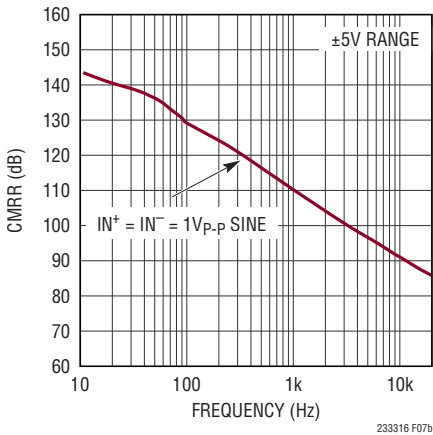
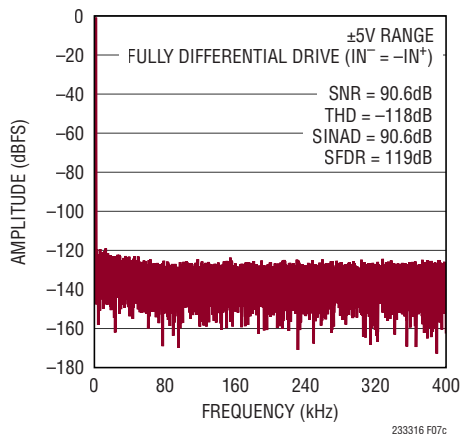
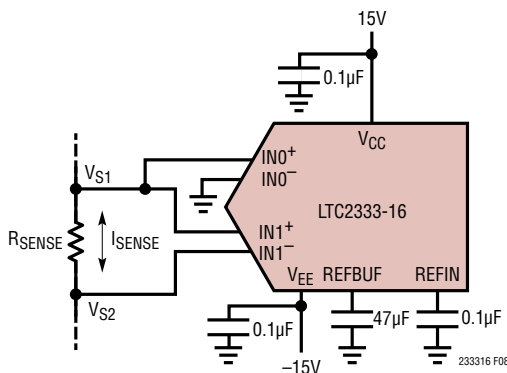


Figure 7b. CMRR vs Input Frequency. Circuit Shown in Figure 7a

Figure 7c. $IN^+/IN^- = 450\text{mV}$ 2kHz Fully Differential Sine, $0\text{V} \leq V_{CM} \leq 24\text{V}$, 32k Point FFT, $f_{SAMPL} = 800\text{ksps}$. Circuit Shown in Figure 7a

ONLY CHANNELS 0 AND 1 SHOWN FOR CLARITY

$$I_{SENSE} = \frac{V_{S1} - V_{S2}}{R_{SENSE}} \quad \begin{matrix} -10.24\text{V} \leq V_{S1} \leq 10.24\text{V} \\ -10.24\text{V} \leq V_{S2} \leq 10.24\text{V} \end{matrix}$$

Figure 8. Sense Voltage (CH0) and Current (CH1) Over a Wide Common Mode Range

Internal Reference with Internal Buffer

The LTC2333-16 has an on-chip, low noise, low drift (20ppm/°C maximum), temperature compensated band-gap reference that is factory trimmed to 2.048V. The reference output connects through a 20kΩ resistor to the REFIN pin, which serves as the input to the on-chip reference buffer, as shown in Figure 9a. When employing the internal bandgap reference, the REFIN pin should be bypassed to GND (Pin 20) close to the pin with a 0.1µF ceramic capacitor to filter wideband noise. The reference buffer amplifies V_{REFIN} to create the converter master reference voltage $V_{REFBUF} = 2 \cdot V_{REFIN}$ on the REFBUF pin, nominally 4.096V when using the internal bandgap reference. Bypass REFBUF to GND (Pin 20) close to the pin with at least a 47µF ceramic capacitor (X7R, 10V, 1210 size or X5R, 10V, 0805 size) to compensate the reference buffer, absorb transient conversion currents, and minimize noise.

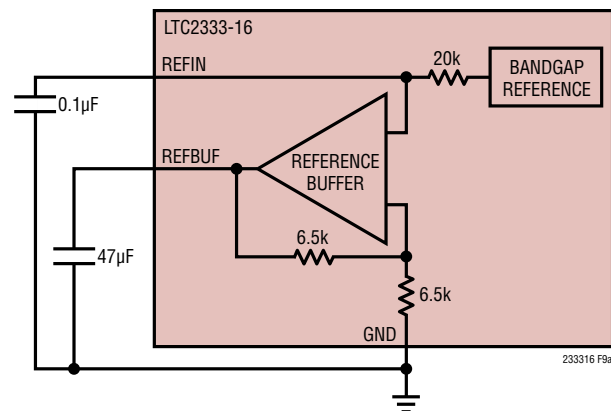


Figure 9a. Internal Reference with Internal Buffer Configuration

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External Reference with Internal Buffer

If more accuracy and/or lower drift is desired, REFIN can be easily overdriven by an external reference since 20k Ω of resistance separates the internal bandgap reference output from the REFIN pin, as shown in Figure 9b. The valid range of external reference voltage overdrive on the REFIN pin is 1.25V to 2.2V, resulting in converter master reference voltages V_{REFBUF} between 2.5V and 4.4V, respectively. Linear Technology offers a portfolio of high performance references designed to meet the needs of many applications. With its small size, low power, and high accuracy, the LTC6655-2.048 is well suited for use with the LTC2333-16 when overdriving the internal reference. The LTC6655-2.048 offers 0.025% (maximum) initial accuracy and 2ppm/ $^{\circ}$ C (maximum) temperature coefficient for high precision applications. The LTC6655-2.048 is fully specified over the H-grade temperature range, complementing the extended temperature range of the LTC2333-16 up to 125 $^{\circ}$ C. Bypassing the LTC6655-2.048 with a 2.7 μ F to 100 μ F ceramic capacitor close to the REFIN pin is recommended.

External Reference with Disabled Internal Buffer

The internal reference buffer supports $V_{REFBUF} = 4.4$ V maximum. By grounding REFIN, the internal buffer may be disabled, allowing REFBUF to be overdriven with an

external reference voltage between 2.5V and 5V, as shown in Figure 9c. Maximum input signal swing and SNR are achieved by overdriving REFBUF using an external 5V reference. The buffer feedback resistors load the REFBUF pin with 13k Ω even when the reference buffer is disabled. The LTC6655-5 offers the same small size, accuracy, drift, and extended temperature range as the LTC6655-2.048, and achieves a typical SNR of 94.8dB when paired with the LTC2333-16. Bypass the LTC6655-5 to GND (Pin 20) close to the REFBUF pin with at least a 47 μ F ceramic capacitor (X7R, 10V, 1210 size or X5R, 10V, 0805 size) to absorb transient conversion currents and minimize noise.

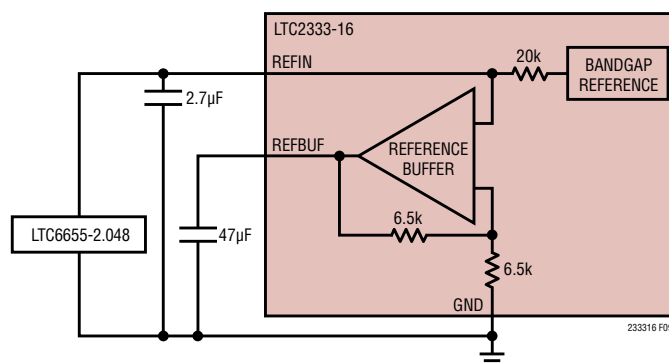


Figure 9b. External Reference with Internal Buffer Configuration

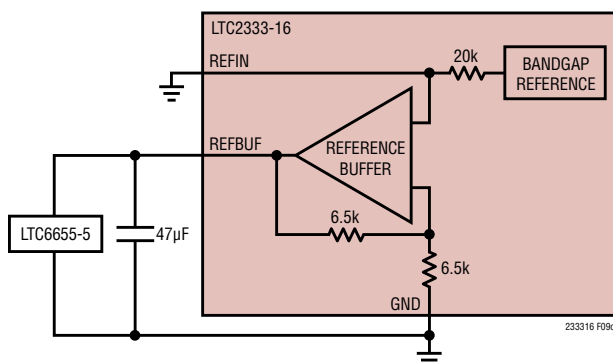


Figure 9c. External Reference with Disabled Internal Buffer Configuration

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The LTC2333-16 converter draws a charge (Q_{CONV}) from the REFBUF pin during each conversion cycle. On short time scales most of this charge is supplied by the external REFBUF bypass capacitor, but on longer time scales all of the charge is supplied by either the reference buffer, or when the internal reference buffer is disabled, the external reference. This charge draw corresponds to a DC current equivalent of $I_{\text{REFBUF}} = Q_{\text{CONV}} \cdot f_{\text{SMPL}}$, which is proportional to sample rate. In applications where a burst of samples is taken after idling for long periods of time, as shown in Figure 10, I_{REFBUF} quickly transitions from approximately 0.4mA to 0.9mA ($V_{\text{REFBUF}} = 5\text{V}$, $f_{\text{SMPL}} = 800\text{ksp/s}$). This current step triggers a transient response in the external reference that must be considered, since any deviation in V_{REFBUF} affects converter accuracy. If an external reference is used to overdrive REFBUF, the fast settling LTC6655 family of references is recommended.

Internal Reference Buffer Transient Response

For optimum performance in applications employing burst sampling, the external reference with internal reference buffer configuration should be used. The internal reference buffer incorporates a proprietary design that minimizes movements in V_{REFBUF} when responding to a burst of conversions following an idle period. Figure 11 compares the burst conversion response of the LTC2333-16 with an input near full scale for two reference configurations. The first configuration employs the internal reference buffer with REFIN externally overdriven by an LTC6655-2.048, while the second configuration disables the internal ref-

erence buffer and overdrives REFBUF with an external LTC6655-4.096. In both cases REFBUF is bypassed to GND with a 47 μF ceramic capacitor.

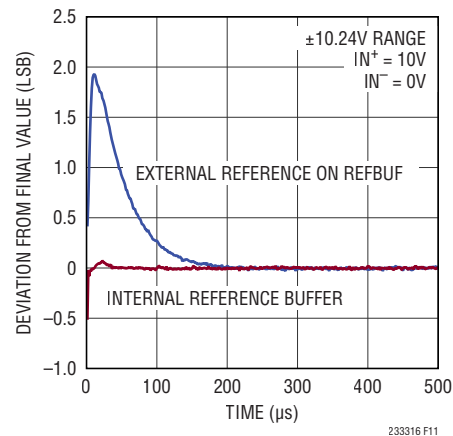


Figure 11. Burst Conversion Response of the LTC2333-16, $f_{\text{SMPL}} = 800\text{ksp/s}$

DYNAMIC PERFORMANCE

Fast Fourier transform (FFT) techniques are used to test the ADC's frequency response, distortion, and noise at the rated throughput. By applying a low distortion sine wave and analyzing the digital output using an FFT algorithm, the ADC's spectral content can be examined for frequencies outside the fundamental. The LTC2333-16 provides guaranteed tested limits for both AC distortion and noise measurements.

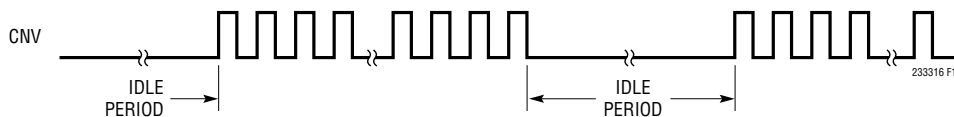


Figure 10. CNV Waveform Showing Burst Sampling

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Signal-to-Noise and Distortion Ratio (SINAD)

The signal-to-noise and distortion ratio (SINAD) is the ratio between the RMS amplitude of the fundamental input frequency and the RMS amplitude of all other frequency components at the A/D output. The output is band-limited to frequencies below half the sampling frequency, excluding DC. Figure 12 shows that the LTC2333-16 achieves a typical SINAD of 94.2dB in the $\pm 10.24\text{V}$ range at a 800ksps sampling rate with a true bipolar 2kHz input signal.

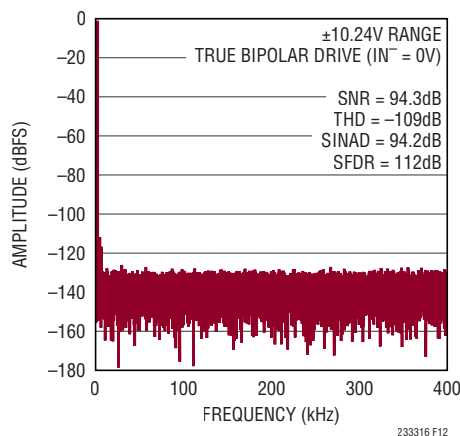


Figure 12. 32k Point FFT $f_{\text{SAMPL}} = 800\text{kps}$, $f_{\text{IN}} = 2\text{kHz}$

Signal-to-Noise Ratio (SNR)

The signal-to-noise ratio (SNR) is the ratio between the RMS amplitude of the fundamental input frequency and the RMS amplitude of all other frequency components except the first five harmonics and DC. Figure 12 shows that the LTC2333-16 achieves a typical SNR of 94.3dB in the $\pm 10.24\text{V}$ range at a 800ksps sampling rate with a true bipolar 2kHz input signal.

Total Harmonic Distortion (THD)

Total harmonic distortion (THD) is the ratio of the RMS sum of all harmonics of the input signal to the fundamental itself. The out-of-band harmonics alias into the frequency band

between DC and half the sampling frequency ($f_{\text{SAMPL}}/2$). THD is expressed as:

$$\text{THD} = 20 \log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 \dots V_N^2}}{V_1}$$

where V_1 is the RMS amplitude of the fundamental frequency and V_2 through V_N are the amplitudes of the second through Nth harmonics, respectively. Figure 12 shows that the LTC2333-16 achieves a typical THD of -109dB ($N = 6$) in the $\pm 10.24\text{V}$ range at a 800ksps sampling rate with a true bipolar 2kHz input signal.

POWER CONSIDERATIONS

The LTC2333-16 requires four power supplies: the positive and negative high voltage power supplies (V_{CC} and V_{EE}), the 5V core power supply (V_{DD}) and the digital input/output (I/O) interface power supply (OV_{DD}). As long as the voltage difference limits of $10\text{V} \leq V_{\text{CC}} - V_{\text{EE}} \leq 38\text{V}$ are observed, V_{CC} and V_{EE} may be independently biased anywhere within their own individual allowed operating ranges, including the ability for V_{EE} to be tied directly to ground. This feature enables the common mode input range of the LTC2333-16 to be tailored to the specific application's requirements. The flexible OV_{DD} supply allows the LTC2333-16 to communicate with CMOS logic operating between 1.8V and 5V, including 2.5V and 3.3V systems. When using LVDS I/O mode, the range of OV_{DD} is 2.375V to 5.25V.

Power Supply Sequencing

The LTC2333-16 does not have any specific power supply sequencing requirements. Care should be taken to adhere to the maximum voltage relationships described in the Absolute Maximum Ratings section. The LTC2333-16 has an internal power-on-reset (POR) circuit which resets the converter on initial power-up and whenever V_{DD} drops below 2V. Once the supply voltage re-enters the nominal

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supply voltage range, the POR reinitializes the ADC. No conversions should be initiated until at least 10ms after a POR event to ensure the initialization period has ended. When employing the internal reference buffer, allow 200ms for the buffer to power up and recharge the REFBUF bypass capacitor. Any conversion initiated before these times will produce invalid results.

TIMING AND CONTROL

CNV Timing

The LTC2333-16 sampling and conversion is controlled by CNV. A rising edge on CNV transitions the S/H circuits from track mode to hold mode, sampling the input signals and initiating a conversion. Once a conversion has been started, it cannot be terminated early except by resetting the ADC, as discussed in the Reset Timing section. For optimum performance, drive CNV with a clean, low jitter signal and avoid transitions on data I/O lines leading up to the rising edge of CNV. Additionally, for best crosstalk performance, avoid high slew rates on the analog inputs for 100ns before and after the rising edge of CNV. Converter status is indicated by the BUSY output, which transitions low-to-high at the start of each conversion and stays high until the conversion is complete. Once CNV is brought high to begin a conversion, it should be returned low between 40ns and 60ns later or after the falling edge of BUSY to minimize external disturbances during the internal conversion process. The CNV timing required to take advantage of the reduced power nap mode of operation is described in the Nap Mode section.

Internal Conversion Clock

The LTC2333-16 has an internal clock that is trimmed to achieve a maximum conversion time of 550ns. With a minimum acquisition time of 670ns, throughput performance of 800ksps is guaranteed without any external adjustments. The LTC2333-16 is a multiplexed ADC and converts one channel per CNV edge, taking a minimum of 1.25 μ s per conversion. Thus, while scanning N channels ($N = 1$ to 8), a complete scan takes at least $1.25 \cdot N \mu$ s and the maximum per-channel throughput is $800/N$ ksps/ch.

Nap Mode

The LTC2333-16 can be placed into nap mode after a conversion has been completed to reduce power consumption between conversions. In this mode a portion of the device circuitry is turned off, including circuits associated with sampling the analog input signals. Nap mode is enabled by keeping CNV high between conversions, as shown in Figure 13. To initiate a new conversion after entering nap mode, bring CNV low and hold for at least 750ns before bringing it high again. The converter acquisition time (t_{ACQ}) is set by the CNV low time (t_{CNVL}) when using nap mode.

Power Down Mode

When PD is brought high, the LTC2333-16 is powered down and subsequent conversion requests are ignored. If this occurs during a conversion, the device powers down once the conversion completes. In this mode, the device draws only a small regulator standby current resulting in a typical power dissipation of 0.68mW. To exit power down

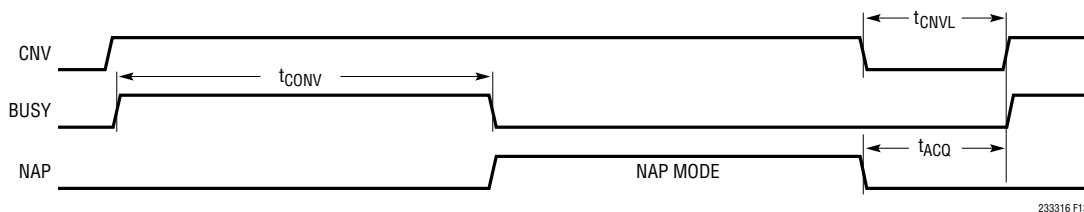


Figure 13. Nap Mode Timing for the LTC2333-16

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mode, bring the PD pin low and wait at least 10ms before initiating a conversion. When employing the internal reference buffer, allow 200ms for the buffer to power up and recharge the REFBUF bypass capacitor. Any conversion initiated before these times will produce invalid results.

Reset Timing

A global reset of the LTC2333-16, equivalent to a power-on-reset event, may be executed without needing to cycle the supplies. This feature is useful when recovering from system-level events that require the state of the entire system to be reset to a known synchronized value. To initiate a global reset, bring PD high twice without an intervening conversion, as shown in Figure 14. The reset event is triggered on the second rising edge of PD, and asynchronously ends based on an internal timer. Reset clears all serial data output registers and restores the internal sequencer default state of converting channels 0 through 7 sequentially, all in SoftSpan 7. If reset is triggered during a conversion, the conversion is immediately halted. The normal power down behavior associated with PD going high is not affected by reset. Once PD is brought low, wait at least 10ms before initiating a conversion. When employing the internal reference buffer, allow 200ms for the buffer to power up and recharge the REFBUF bypass capacitor. Any conversion initiated before these times will produce invalid results.

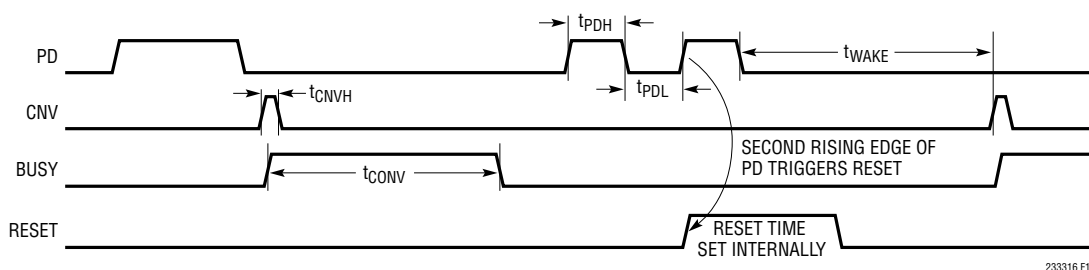


Figure 14. Reset Timing for the LTC2333-16

Power Dissipation vs Sampling Frequency

When nap mode is employed, the power dissipation of the LTC2333-16 decreases as the sampling frequency is reduced, as shown in Figure 15. This decrease in average power dissipation occurs because a portion of the LTC2333-16 circuitry is turned off during nap mode, and the fraction of the conversion cycle (t_{CYC}) spent napping increases as the sampling frequency (f_{SAMPL}) is decreased.

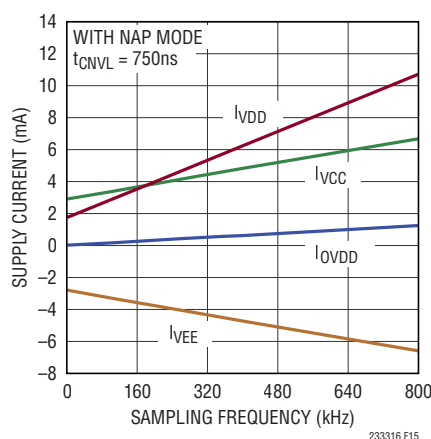


Figure 15. Power Dissipation of the LTC2333-16 Decreases with Decreasing Sampling Frequency

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DIGITAL INTERFACE

The LTC2333-16 features CMOS and LVDS serial interfaces, selectable using the LVDS/ $\overline{\text{CMOS}}$ pin. The flexible OV_{DD} supply allows the LTC2333-16 to communicate with any CMOS logic operating between 1.8V and 5V, including 2.5V and 3.3V systems, while the LVDS interface supports low noise digital designs. Together, these I/O interface options enable the LTC2333-16 to communicate equally well with legacy microcontrollers and modern FPGAs.

Serial CMOS I/O Mode

As shown in Figure 16, in CMOS I/O mode the serial data bus consists of a serial clock input, SCKI, serial data input, SDI, serial clock output, SCKO, and serial data output, SDO. Communication with the LTC2333-16 across this bus occurs during predefined data transaction windows.

Within a window, the device accepts control words on SDI to configure the SoftSpan range and channel for the next conversion and program the sequencer, and outputs 24-bit packets containing the conversion result and configuration information from the previous conversion on SDO.

New data transaction windows open 10ms after powering up or resetting the LTC2333-16, and at the end of each conversion on the falling edge of BUSY. The data transaction should be completed with a minimum t_{QUIET} time of 20ns prior to the start of the next conversion, as shown in Figure 16. New control words are only accepted within this recommended data transaction window, but configuration changes take effect immediately with no additional analog input settling time required before starting the next conversion.

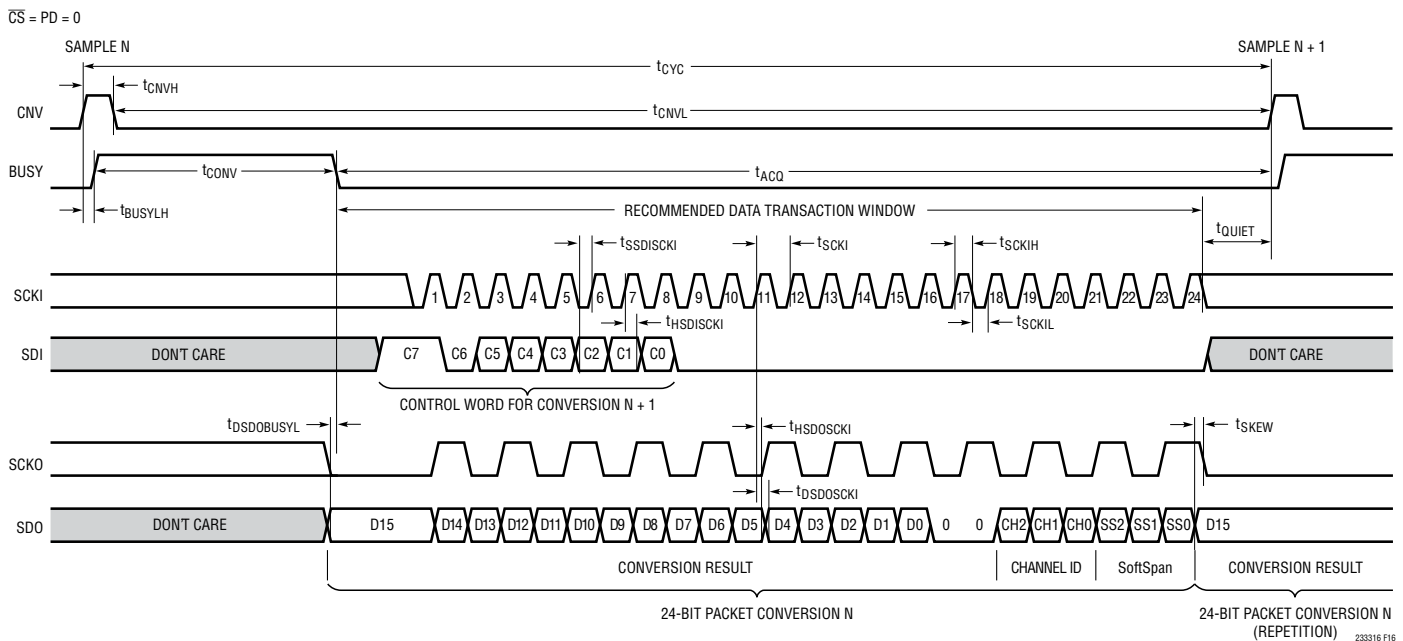


Figure 16. Serial CMOS I/O Mode, Direct Per-Conversion Configuration

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Just prior to the falling edge of BUSY and the opening of a new data transaction window, SCKO is forced low and SDO is updated with the latest conversion result from the just-completed conversion. Rising edges on SCKI serially clock the conversion result and analog input channel configuration information out on SDO and trigger transitions on SCKO that are skew-matched to the data on SDO. The resulting SCKO frequency is half that of SCKI.

SCKI rising edges also latch control words provided on SDI, which are used to set the SoftSpan range and channel for the next conversion, and program the sequencer. See the section Configuring the Multiplexer and SoftSpan Range for further details. SCKI is allowed to idle either high or low in CMOS I/O mode. As shown in Figure 17, the CMOS bus is enabled when \overline{CS} is low and is disabled and Hi-Z when \overline{CS} is high, allowing the bus to be shared across multiple devices.

The data on SDO are formatted as a 24-bit packet consisting of a 16-bit conversion result followed by two zeros, 3-bit analog channel ID, and 3-bit SoftSpan code, all presented MSB first. As suggested in Figures 16 and 17, if more than 24 SCKI clocks are applied, the 24-bit packet is repeated indefinitely on SDO.

When interfacing the LTC2333-16 with a standard SPI bus, capture output data at the receiver on rising edges of SCKI. SCKO is not used in this case. In other applications, such as interfacing the LTC2333-16 with an FPGA or CPLD, rising and falling edges of SCKO may be used to capture serial output data on SDO in double data rate (DDR) fashion. Capturing data using SCKO adds robustness to delay variations over temperature and supply.

The LTC2333-16 guarantees a minimum data transfer window ($t_{ACQ} - t_{QUIET}$) of 650ns while converting at 800ksps. Thus, if an application needs to read the full 24-bit packet of conversion result plus channel ID and SoftSpan, the minimum usable SCKI frequency is 37MHz. Applications needing to read only the conversion result may send only 16 SCKI pulses and thus have a minimum SCKI frequency of 25MHz. The LTC2333-16 supports CMOS SCKI frequencies up to 100MHz.

Configuring the Multiplexer and SoftSpan Range in CMOS I/O Mode

On power-up and after a reset, the LTC2333-16 defaults to converting channels 0 through 7 sequentially, all in SoftSpan 7. If this configuration does not need to be changed, simply hold SDI low.

The LTC2333-16 multiplexer and SoftSpan range may be controlled in two ways, depending on the needs of the application. If the desired sequence of channels and SoftSpan ranges are known ahead of time, the LTC2333-16's internal sequencer may be programmed with a sequence of up to 16 configurations, and will cycle through those configurations on subsequent conversions without further user intervention. Alternately, if ultimate flexibility is desired, the LTC2333-16 may be directly controlled by overwriting the sequencer each conversion with the channel and SoftSpan range for the following conversion. This reconfiguration has no latency and requires no additional settling time or digital I/O overhead.

Using the Sequencer

To use the internal sequencer of the LTC2333-16, first program it as described below with the desired sequence of up to 16 configurations. Each of these configurations specifies the desired channel number and SoftSpan range for one conversion. The LTC2333-16 will then apply the first configuration to the first conversion, the second configuration to the second conversion, and so on until the end of the programmed sequence is reached, at which point the cycle will start again from the beginning.

Each data transaction window is an opportunity to program the sequencer by clocking in a series of 8-bit control words on SDI, each specifying a channel number and SoftSpan range, as shown in Figures 16 and 17. To program the sequencer with a series of up to 16 conversion configurations, write in the corresponding control words in the desired conversion order during a single data transaction. Words beyond the 16th valid word will be ignored.

APPLICATIONS INFORMATION

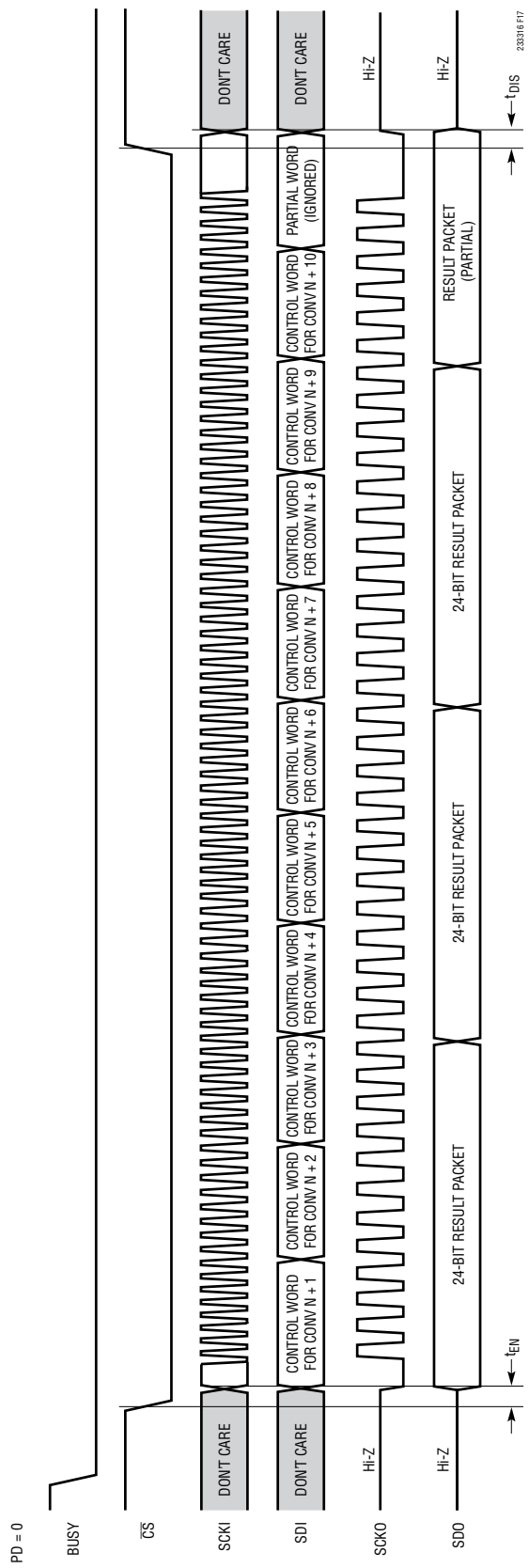


Figure 17. Programming the Sequencer for a 10-Conversion Sequence, Serial CMOS Bus Response to CS

APPLICATIONS INFORMATION

The control word format is as follows:

C[7]	C[6]	C[5]	C[4]	C[3]	C[2]	C[1]	C[0]
V	0	CH[2]	CH[1]	CH[0]	SS[2]	SS[1]	SS[0]

The V bit (C[7]) controls whether the LTC2333-16 should consider this a valid word. Any words which have V = 0 are considered invalid and are ignored (though valid words will still be accepted after an invalid word). Words which have V = 1 will be added to the sequencer in the order provided. The C[6] bit is reserved for future use and should be set to 0. The CH[2:0] (C[5:3]) bits are a binary value 0 to 7 controlling the channel to be converted. The SS[2:0] (C[2:0]) bits specify the desired SoftSpan range for the conversion, as described in Table 1.

Sequencer programming is completed when the next conversion is started. At this time, any incomplete words are considered invalid and discarded. If one or more valid words were provided, the sequencer is completely overwritten with the new sequence, and the just-initiated conversion employs the first provided configuration.

If no valid words were provided during the data transaction window, the sequencer program is unchanged, and the pointer advances to the next entry in the previously programmed cycle to configure the next conversion.

Thus, once the sequencer has been programmed, simply hold SDI low during subsequent data transactions to cycle continually through the programmed sequence of configurations.

Direct Per-Conversion Configuration

As a special case of the sequencer, the LTC2333-16 multiplexer and SoftSpan range can be directly controlled every conversion with no latency and no additional settling time or digital I/O overhead. To use the part in this direct fashion, simply supply one control word on SDI during a data transaction to specify the desired channel number and SoftSpan range for the following conversion, as shown in Figure 16.

If the desired channel and SoftSpan range for conversion N+1 are known before seeing the result of conversion N, specify the configuration by clocking in the corresponding control word on SDI while clocking out the first 8 bits, then hold SDI low. This particular use case is illustrated in Figure 16. If the desired configuration is not known until after the conversion data has been read, clock in 24 zeros on SDI while the 24 bits of data are being read out; since the V bits of those words are then 0, they are ignored. Once the configuration has been determined, clock in 8 more bits on SDI which specify the desired configuration for conversion N+1.

Serial LVDS I/O Mode

In LVDS I/O mode, information is transmitted using positive and negative signal pairs (LVDS⁺/LVDS⁻) with bits differentially encoded as (LVDS⁺ – LVDS⁻). These signals are typically routed using differential transmission lines with 100Ω characteristic impedance. Logical 1s and 0s are nominally represented by differential +350mV and –350mV, respectively. For clarity, all LVDS timing diagrams and interface discussions adopt the logical rather than physical convention.

As shown in Figure 18, in LVDS I/O mode the serial data bus consists of a serial clock differential input, SCKI, serial data differential input, SDI, serial clock differential output, SCKO, and serial data differential output, SDO. Communication with the LTC2333-16 across this bus occurs during predefined data transaction windows. Within a window, the device accepts control words on SDI to configure the SoftSpan range and channel for the next conversion and program the sequencer, and outputs 24-bit packets containing the conversion result and configuration information from the previous conversion on SDO.

New data transaction windows open 10ms after powering up or resetting the LTC2333-16, and at the end of each conversion on the falling edge of BUSY. The data transaction should be completed with a minimum t_{QUIET}

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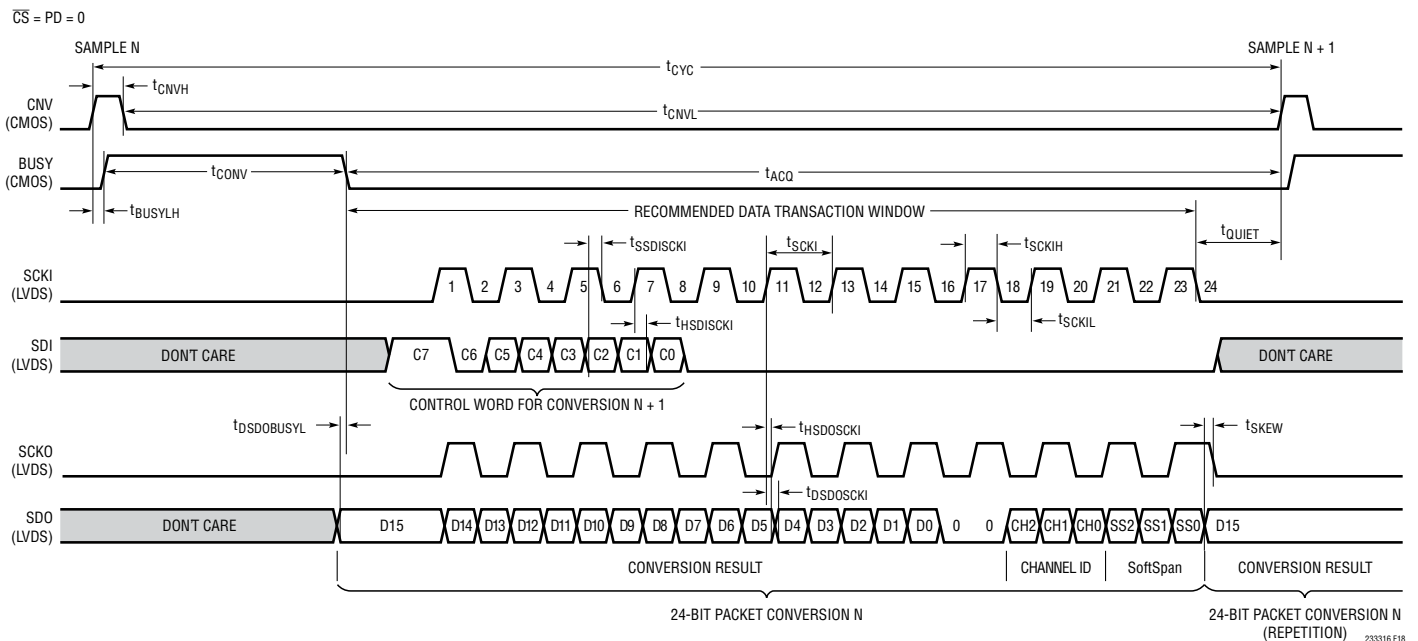


Figure 18. Serial LVDS I/O Mode, Direct Per-Conversion Configuration

time of 20ns prior to the start of the next conversion, as shown in Figure 18. New control words are only accepted within this recommended data transaction window, but configuration changes take effect immediately with no additional analog input settling time required before starting the next conversion.

Just prior to the falling edge of BUSY and the opening of a new data transaction window, SDO is updated with the latest conversion result from the just-completed conversion. Both rising and falling edges on SCKI serially clock the conversion result and analog input channel configuration information out on SDO. SCKI is also echoed on SCKO, skew-matched to the data on SDO. Whenever possible, it is recommended that rising and falling edges of SCKO be used to capture DDR serial output data on SDO, as this will yield the best robustness to delay variations over supply and temperature.

SCKI rising and falling edges also latch control words provided on SDI, which are used to set the SoftSpan range and channel for the next conversion, and program the sequencer. See the section Configuring the Multiplexer and SoftSpan Range in LVDS I/O Mode for further details. As shown in Figure 19, the LVDS bus is enabled when \overline{CS} is low and is disabled and Hi-Z when \overline{CS} is high, allowing the bus to be shared across multiple devices. Due to the high speeds often involved in LVDS signaling, LVDS bus sharing must be carefully considered. Transmission line limitations imposed by the shared bus may limit the maximum achievable bus clock speed. LVDS inputs are internally terminated with a 100 Ω differential resistor when \overline{CS} is low, while outputs must be differentially terminated with a 100 Ω resistor at the receiver (FPGA). SCKI must idle in the low state in LVDS I/O mode, including when transitioning \overline{CS} .

For more information www.linear.com/LTC2333-16



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The data on SDO are formatted as a 24-bit packet consisting of a 16-bit conversion result followed by two zeros, 3-bit analog channel ID, and 3-bit SoftSpan code, all presented MSB first. As suggested in Figures 18 and 19, if more than 24 SCKI clocks are applied, the 24-bit packet is repeated indefinitely on SDO.

The LTC2333-16 guarantees a minimum data transfer window ($t_{ACQ} - t_{QUIET}$) of 650ns while converting at 800ksps. Thus, if an application needs to read the full 24-bit packet of conversion result plus channel ID and SoftSpan, the minimum usable SCKI frequency is 19MHz (38Mbps). Applications needing to read only the conversion result may send only 16 SCKI edges and thus have a minimum SCKI frequency of 13MHz (26Mbps). The LTC2333-16 supports LVDS SCKI frequencies up to 250MHz (500Mbps).

Configuring the Multiplexer and SoftSpan Range in LVDS I/O Mode

On power-up and after a reset, the LTC2333-16 defaults to converting channels 0 through 7 sequentially, all in SoftSpan 7. If this configuration does not need to be changed, simply hold SDI at an LVDS low level.

The LTC2333-16 multiplexer and SoftSpan range may be controlled in two ways, depending on the needs of the application. If the desired sequence of channels and SoftSpan ranges are known ahead of time, the LTC2333-16's internal sequencer may be programmed with a sequence of up to 16 configurations, and will cycle through those configurations on subsequent conversions without further user intervention. Alternately if ultimate flexibility is desired, the LTC2333-16 may be directly controlled by overwriting the sequencer each conversion with the channel and SoftSpan range for the following conversion. This reconfiguration has no latency and requires no additional settling time or digital I/O overhead.

Using the Sequencer

To use the internal sequencer of the LTC2333-16, first program it as described below with the desired sequence of up to 16 configurations. Each of these configurations

specifies the desired channel number and SoftSpan range for one conversion. The LTC2333-16 will then apply the first configuration to the first conversion, the second configuration to the second conversion, and so on until the end of the programmed sequence is reached, at which point the cycle will start again from the beginning.

Each data transaction window is an opportunity to program the sequencer by clocking in a series of 8-bit control words on SDI, each specifying a channel number and SoftSpan range, as shown in Figures 18 and 19. To program the sequencer with a series of up to 16 conversion configurations, write in the corresponding control words in the desired conversion order during a single data transaction. Words beyond the 16th valid word will be ignored.

The control word format is as follows:

C[7]	C[6]	C[5]	C[4]	C[3]	C[2]	C[1]	C[0]
V	0	CH[2]	CH[1]	CH[0]	SS[2]	SS[1]	SS[0]

The V bit (C[7]) controls whether the LTC2333-16 should consider this a valid word. Any words which have V = 0 are considered invalid and are ignored (though valid words will still be accepted after an invalid word). Words which have V = 1 will be added to the sequencer in the order provided. The C[6] bit is reserved for future use and should be set to 0. The CH[2:0] (C[5:3]) bits are a binary value 0 to 7 controlling the channel to be converted. The SS[2:0] (C[2:0]) bits specify the desired SoftSpan range for the conversion, as described in Table 1.

Sequencer programming is completed when the next conversion is started. At this time, any incomplete words are considered invalid and discarded. If one or more valid words were provided, the sequencer is completely overwritten with the new sequence, and the just-initiated conversion employs the first provided configuration.

If no valid words were provided during the data transaction window, the sequencer program is unchanged, and the pointer advances to the next entry in the previously programmed cycle to configure the next conversion.

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Thus, once the sequencer has been programmed, simply hold SDI at an LVDS low level during subsequent data transactions to cycle continually through the programmed sequence of configurations.

Direct Per-Conversion Configuration

As a special case of the sequencer, the LTC2333-16 multiplexer and SoftSpan range can be directly controlled every conversion with no latency and no additional settling time or digital I/O overhead. To use the part in this direct fashion, simply supply one control word on SDI during a data transaction to specify the desired channel number and SoftSpan range for the following conversion, as shown in Figure 18.

If the desired channel and SoftSpan range for conversion N+1 are known before seeing the result of conversion N, specify the configuration by clocking in the corresponding control word on SDI while clocking out the first 8 bits, then hold SDI at an LVDS low level. This particular use case is illustrated in Figure 18. If the desired configuration is not known until after the conversion data has been read, clock in 24 zeros on SDI while the 24 bits of data are being read out; since the V bits of those words are then 0, they are ignored. Once the configuration has been determined, clock in 8 more bits on SDI which specify the desired configuration for conversion N+1.

BOARD LAYOUT

To obtain the best performance from the LTC2333-16, a four-layer printed circuit board (PCB) is recommended. Layout for the PCB should ensure the digital and analog signal lines are separated as much as possible. In particular, care should be taken not to run any digital clocks or signals alongside analog signals or underneath the ADC. Also minimize the length of the REFBUF to GND (Pin 20) bypass capacitor return loop, and avoid routing CNV near signals which could potentially disturb its rising edge.

Supply bypass capacitors should be placed as close as possible to the supply pins. Low impedance common returns for these bypass capacitors are essential to the low noise operation of the ADC. A single solid ground plane is recommended for this purpose. When possible, screen the analog input traces using ground.

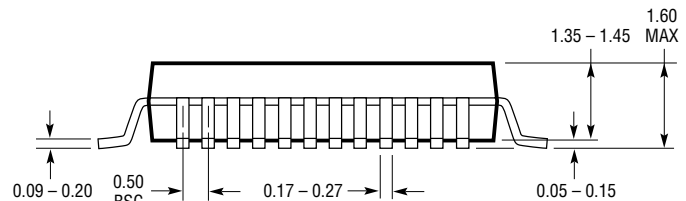
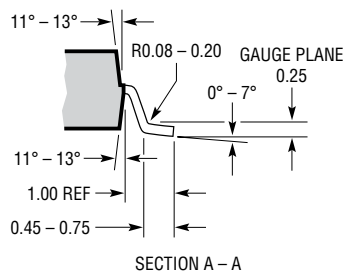
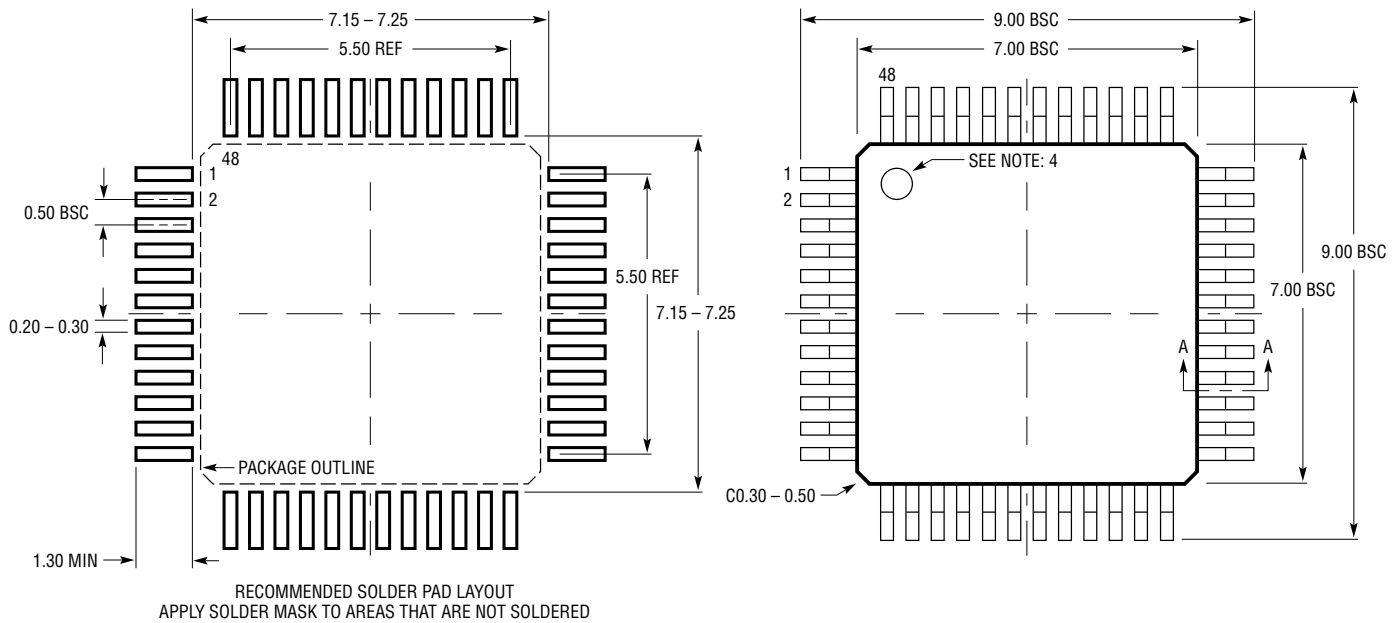
Reference Design

For a detailed look at the reference design for this converter, including schematics and PCB layout, please refer to [DC2365](#), the evaluation kit for the LTC2333-16.

PACKAGE DESCRIPTION

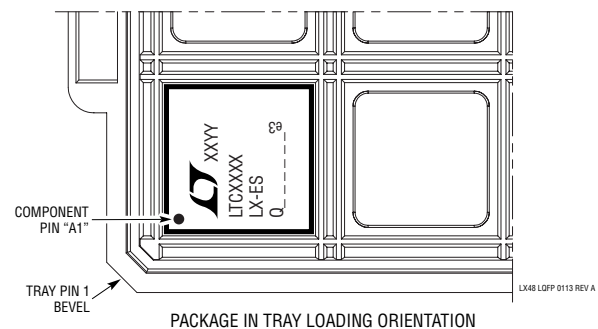
Please refer to <http://www.linear.com/product/LTC2333-16#packaging> for the most recent package drawings.

LX Package 48-Lead Plastic LQFP (7mm × 7mm) (Reference LTC DWG # 05-08-1760 Rev A)



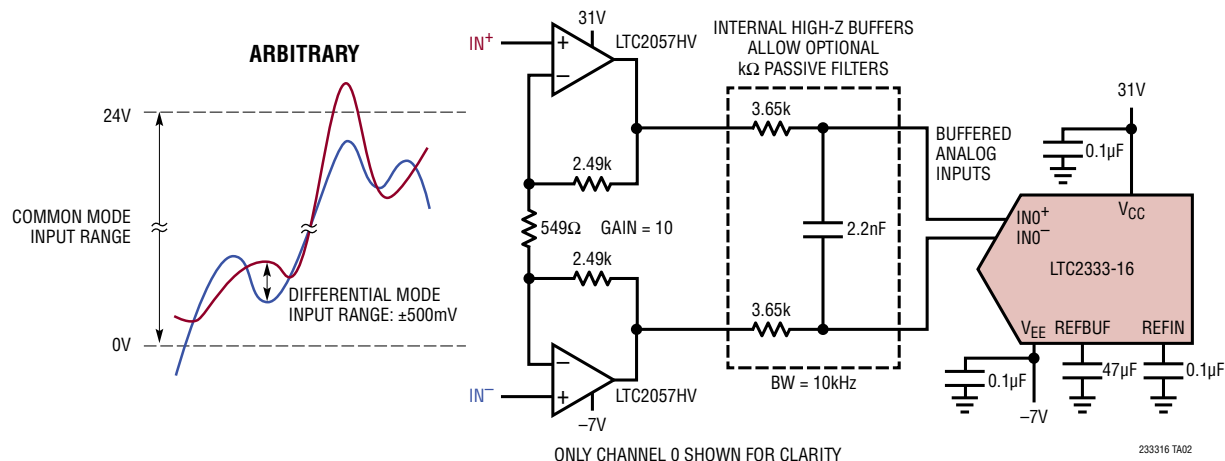
NOTE:

1. PACKAGE DIMENSIONS CONFORM TO JEDEC #MS-026 PACKAGE OUTLINE
2. DIMENSIONS ARE IN MILLIMETERS
3. DIMENSIONS OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.25mm ON ANY SIDE, IF PRESENT
4. PIN-1 IDENTIFIER IS A MOLDED INDENTATION, 0.50mm DIAMETER
5. DRAWING IS NOT TO SCALE



TYPICAL APPLICATION

Amplify Differential Signals with Gain of 10 Over a Wide Common Mode Range with Buffered Analog Inputs



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
ADCs		
LTC2358-18/LTC2358-16	Buffered 18-/16-Bit, 200ksps/Ch, 8-Channel Simultaneous Sampling, $\pm 3.51\text{LSB}/\pm 1\text{LSB}$ INL, Serial ADC	Buffered $\pm 10.24\text{V}$ SoftSpan Inputs with Wide Common Mode Range, 96/94dB SNR, Serial CMOS and LVDS I/O, 7mm \times 7mm LQFP-48 Package
LTC2335-18/LTC2335-16	18-/16-Bit, 1Msps, 8-Channel Multiplexed, $\pm 3\text{LSB}/\pm 1\text{LSB}$ INL, Serial ADC	$\pm 10.24\text{V}$ SoftSpan Inputs with Wide Common Mode Range, 97dB/94dB SNR, Serial CMOS and LVDS I/O, 7mm \times 7mm LQFP-48 Package
LTC2348-18/LTC2348-16	18-/16-Bit, 200ksps/Ch, 8-Channel Simultaneous Sampling, $\pm 3/\pm 1\text{LSB}$ INL, Serial ADC	$\pm 10.24\text{V}$ SoftSpan Inputs with Wide Common Mode Range, 97/94dB SNR, Serial CMOS and LVDS I/O, 7mm \times 7mm LQFP-48 Package
LTC2345-18/LTC2345-16	18-/16-Bit, 200ksps/Ch, 8-Channel Simultaneous Sampling, $\pm 5/\pm 1.25\text{LSB}$ INL, Serial ADC	$\pm 4.096\text{V}$ SoftSpan Inputs with Wide Common Mode Range, 92/91dB SNR, Serial CMOS and LVDS I/O, 7mm \times 7mm QFN-48 Package
LTC2338-18/LTC2337-18/LTC2336-18	18-Bit, 1Msps/500ksps/250ksps, Serial, Low Power ADC	5V Supply, $\pm 10.24\text{V}$ Fully Differential Input, 100dB SNR, MSOP-16 Package
LTC2328-18/LTC2327-18/LTC2326-18	18-Bit, 1Msps/500ksps/250ksps, Serial, Low Power ADC	5V Supply, $\pm 10.24\text{V}$ Pseudo-Differential Input, 95dB SNR, MSOP-16 Package
LTC2373-18/LTC2372-18	18-Bit, 1Msps/500ksps, 8-Channel, Serial ADC	5V Supply, 8-Channel Multiplexed, Configurable Input Range, 100dB SNR, DGC, 5mm \times 5mm QFN-32 Package
LTC1859/LTC1858/LTC1857	16-/14-/12-Bit, 8-Channel, 100ksps, Serial ADC	$\pm 10\text{V}$, SoftSpan, Single-Ended or Differential Inputs, Single 5V Supply, SSOP-28 Package
DACs		
LTC2756/LTC2757	18-Bit, Serial/Parallel I_{OUT} SoftSpan DAC	$\pm 1\text{LSB}$ INL/DNL, Software-Selectable Ranges, SSOP-28/7mm \times 7mm LQFP-48 Package
LTC2668	16-Channel 16-/12-Bit $\pm 10\text{V}$ V_{OUT} SoftSpan DACs	$\pm 4\text{LSB}$ INL, Precision Reference 10ppm/ $^{\circ}\text{C}$ Max, 6mm \times 6mm QFN-40 Package
References		
LTC6655	Precision Low Drift Low Noise Buffered Reference	5V/2.5V/2.048V/1.25V, 2ppm/ $^{\circ}\text{C}$, 0.25ppm Peak-to-Peak Noise, MSOP-8 Package
LT6657	Precision Low Drift Low Noise Buffered Reference	5V/3V/2.5V, 1.5ppm/ $^{\circ}\text{C}$, 0.5ppm Peak-to-Peak Noise, MSOP-8 Package
Amplifiers		
LTC2057/LTC2057HV	High Voltage, Low Noise Zero-Drift Op Amp	Maximum Input Offset: 4.5 μV , Supply Voltage Range: 4.75V to 60V
LT6020	Dual, Micropower, 5V μs , Rail-to-Rail Op Amp	Maximum Input Offset: 30 μV , Maximum Supply Current: 100 μA /Amplifier
LT1354/LT1355/LT1356	Single/Dual/Quad 1mA, 12MHz, 400V/ μs Op Amp	Good DC Precision, Stable with All Capacitive Loads

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